

Vincotech

flow PIMO + PFC 2nd		600 V / 6 A
Features		flow 0 housing
<ul style="list-style-type: none"> Clip in PCB mounting Trench Fieldstop IGBT's for low saturation losses Latest generation superjunction MOSFET for PFC 		 17mm housing solder pins 12mm housing Press-fit pins
Target Applications		Schematic
<ul style="list-style-type: none"> Industrial Drives Embedded Drives 		
Types		
<ul style="list-style-type: none"> 10-F006PPA006SB-M682B 10-PC06PPA006SB-M682B06Y 		

Maximum Ratings

 $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Rectifier Diode				
Repetitive peak reverse voltage	V_{RRM}		1600	V
DC forward current	I_{FAV}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	34 35	A
Surge forward current	I_{FSM}		200	A
I ² t-value	I^2t	$t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	200	A^2s
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	43 66	W
Maximum Junction Temperature	T_{jmax}		150	$^\circ\text{C}$

PFC Switch

Drain to source breakdown voltage	V_{DS}		600	V
DC drain current	I_D	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	10 12	A
Pulsed drain current	I_{Dpulse}	t_p limited by T_{jmax}	59	A
Avalanche energy, single pulse	E_{AS}	$I_D = 3,4 \text{ A}$ $V_{DD} = 50 \text{ V}$	418	mJ
Avalanche energy, repetitive	E_{AR}	$I_D = 3,4 \text{ A}$ $V_{DD} = 50 \text{ V}$	0,63	mJ
Avalanche current, repetitive	I_{AR}		3,4	A
MOSFET dv/dt ruggedness	dv/dt		50	V/ns
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	53 81	W
Gate-source peak voltage	V_{GSS}		± 20	V
Reverse diode dv/dt	dv/dt		15	V/ns
Maximum Junction Temperature	T_{jmax}		150	$^\circ\text{C}$



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Maximum Ratings

 $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
PFC Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		600	V
DC forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	8 8	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	18	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	45 68	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$
PFC Shunt				
DC forward current	I_F		10	A
Power dissipation per Shunt	P_{tot}		5	W
Inverter Switch				
Collector-emitter break down voltage	V_{CE}		600	V
DC collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	8 8	A
Pulsed collector current	I_{CRM}	t_p limited by T_{jmax}	18	A
Turn off safe operating area		$V_{CE} \leq 400\text{ V}$, $T_j \leq T_{op\ max}$	18	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	36 54	W
Gate-emitter peak voltage	V_{GE}		20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{V}$	6 360	μs V
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		600	V
DC forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	8 8	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	12	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ $T_c = 80^\circ\text{C}$	27 41	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$
DC link Capacitor				
Max.DC voltage	V_{MAX}		500	V
Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{op}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$
Isolation Properties				
Isolation voltage	V_{is}	$t = 2\text{ s}$ DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance		12 mm housing Press-fit pins 17 mm housing solder pins	9,16 min 12,7	mm
Comparative tracking index	CTI		>200	



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] or V_{GS} [V]	V_r [V] or V_{CE} [V] or V_{DS} [V]	I_c [A] or I_F [A] or I_D [A]	T_j [$^{\circ}$ C]	Min	Typ	Max	

Rectifier Diode

Forward voltage	V_F				25	25 125		1,17		V
Threshold voltage (for power loss calc. only)	V_{to}				25	25 125		0,92 0,81		V
Slope resistance (for power loss calc. only)	r_t				25	25 125		10,9 14,4		m Ω
Reverse current	I_r			1600		25			0,05	mA
Thermal resistance chip to heatsink	$R_{th(j-s)}$	phase - change material $\lambda = 3,4$ W/mK						1,61		K/W

PFC Switch

Static drain to source ON resistance	$r_{DS(on)}$		10		6	25		203 398		m Ω
Gate threshold voltage	$V_{(GS)th}$	$V_{GS} = V_{DS}$			0,00063	25		2,4	3,0	V
Gate to Source Leakage Current	I_{GSS}		20	0		25			100	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	600		25			1000	nA
Turn On Delay Time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	10	400	6	25		17		
Rise Time	t_r					125		16		
Turn off delay time	$t_{d(off)}$					25		2		ns
Fall time	t_f					125		2		
Turn-on energy loss	E_{on}					25		103		
Turn-off energy loss	E_{off}					125		113		
Total gate charge	Q_{GE}	$f = 1$ MHz	0/10	480	9,5	25		6		
Gate to source charge	Q_{GS}					125		9		
Gate to drain charge	Q_{GD}					25		0,045		
Input capacitance	C_{iss}					125		0,091		
Output capacitance	C_{oss}	$R_{gon} = 4 \Omega$	10	400	6	25		0,006		mWs
Gate resistance	R_G					125		0,007		
Thermal resistance chip to heatsink	$R_{th(j-s)}$					25		1,32		K/W

PFC Diode

Forward voltage	V_F				6	25 125		2,83 1,66		V
Reverse leakage current	I_{rm}			600		25 125			50 500	μ A
Peak recovery current	I_{RRM}	$R_{gon} = 4 \Omega$	10	400	6	25		29		A
Reverse recovery time	t_{rr}					125		31		
Reverse recovery charge	Q_{rr}					25		9		ns
Reverse recovered energy	E_{rec}					125		15		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		0,12		μ C
Thermal resistance chip to heatsink	$R_{th(j-s)}$					125		0,29		

PFC Shunt

R1 value	R							50		m Ω
Temperature coefficient	t_c	20 $^{\circ}$ C to 60 $^{\circ}$ C							30	ppm/K
Internal heat resistance	R_{thi}								10	K/W
Inductance	L								3	nH



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Characteristic Values

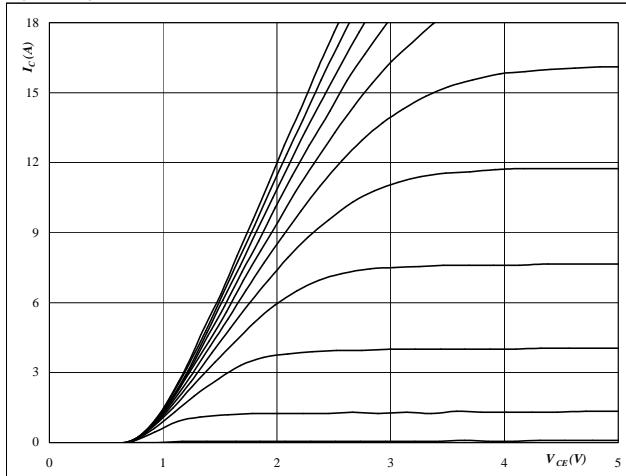
Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] or V_{GS} [V]	V_r [V] or V_{CE} [V] or V_{DS} [V]	I_c [A] or I_F [A] or I_D [A]	T_j [$^{\circ}$ C]	Min	Typ	Max	
Inverter Switch										
Gate emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE} = V_{GE}$			0,00009	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CESat}		15		6	25 125		1,52 1,71		V
Collector-emitter cut-off current incl. Diode	I_{CES}		0	600		25			0,027	mA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Integrated Gate resistor	R_{gint}							none		Ω
Turn-on delay time	$t_{d(\text{on})}$					25 125		103 101		
Rise time	t_r					25 125		23 26		ns
Turn-off delay time	$t_{d(\text{off})}$	$R_{\text{goff}} = 64 \Omega$ $R_{\text{gon}} = 64 \Omega$	± 15	400	6	25 125		154 177		
Fall time	t_f					25 125		96 105		
Turn-on energy loss	E_{on}					25 125		0,19 0,25		mWs
Turn-off energy loss	E_{off}					25 125		0,21 0,27		
Input capacitance	C_{ies}							368		
Output capacitance	C_{oss}	$f = 1 \text{ MHz}$	0	25		25		28		pF
Reverse transfer capacitance	C_{rss}							11		
Gate charge	Q_G		± 15	480	6	25		42		nC
Thermal resistance chip to heatsink	$R_{\text{th(j-s)}}$	phase - change material $\lambda = 3,4 \text{ W/mK}$						2,66		K/W
Inverter Diode										
Diode forward voltage	V_F				6	25 125	1,25	1,62 1,53	1,95	V
Peak reverse recovery current	I_{RRM}					25 125		3 4		A
Reverse recovery time	t_{rr}					25 125		236 341		ns
Reverse recovered charge	Q_{rr}	$R_{\text{gon}} = 64 \Omega$	± 15	400	6	25 125		0,32 0,60		μC
Peak rate of fall of recovery current	$(di_{rf}/dt)_{\text{max}}$					25 125		12 30		$\text{A}/\mu\text{s}$
Reverse recovered energy	E_{rec}					25 125		0,09 0,17		mWs
Thermal resistance chip to heatsink	$R_{\text{th(j-s)}}$	phase - change material $\lambda = 3,4 \text{ W/mK}$						3,55		K/W
DC link Capacitor										
C value	C							100		nF
Thermistor										
Rated resistance	R					25				Ω
Deviation of R100	$\Delta R/R$	$R_{100} = 1486 \Omega$				100	-5		5	%
Power dissipation	P					25		210		mW
Power dissipation constant						25		3,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				25				K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				25		4000		K
Vincotech NTC Reference									A	

Inverter Characteristics

Figure 1
Typical output characteristics

Inverter IGBT

$$I_C = f(V_{CE})$$


At

$$t_p = 250 \mu\text{s}$$

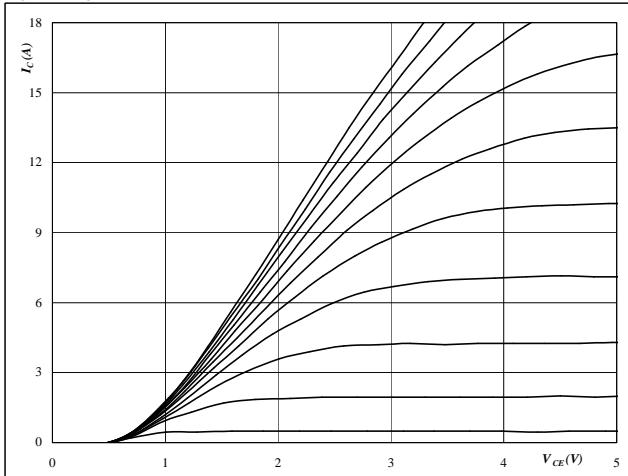
$$T_j = 25^\circ\text{C}$$

 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 2
Typical output characteristics

Inverter IGBT

$$I_C = f(V_{CE})$$


At

$$t_p = 250 \mu\text{s}$$

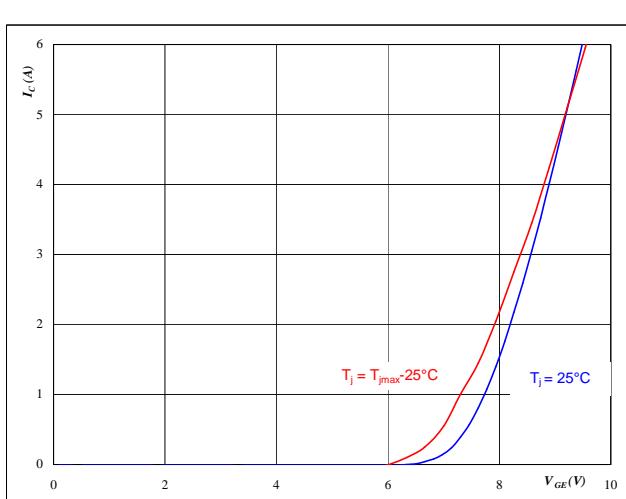
$$T_j = 125^\circ\text{C}$$

 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3
Typical transfer characteristics

Inverter IGBT

$$I_C = f(V_{GE})$$


At

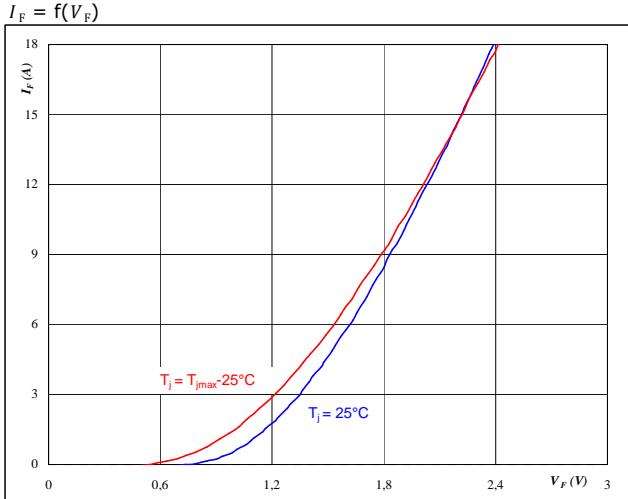
$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

Figure 4
Typical diode forward current as a function of forward voltage

Inverter Diode

$$I_F = f(V_F)$$


At

$$t_p = 250 \mu\text{s}$$



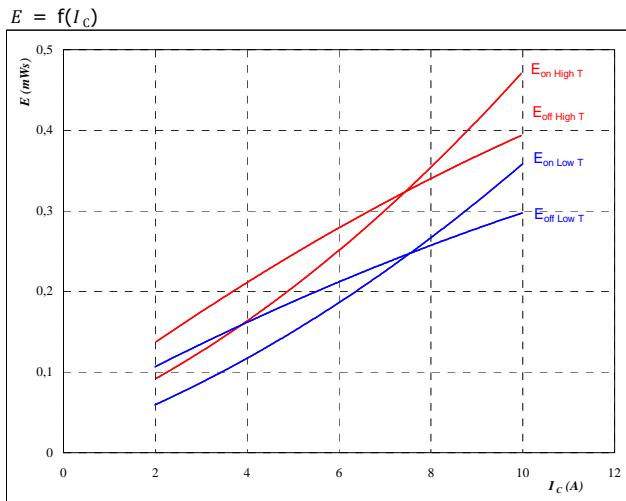
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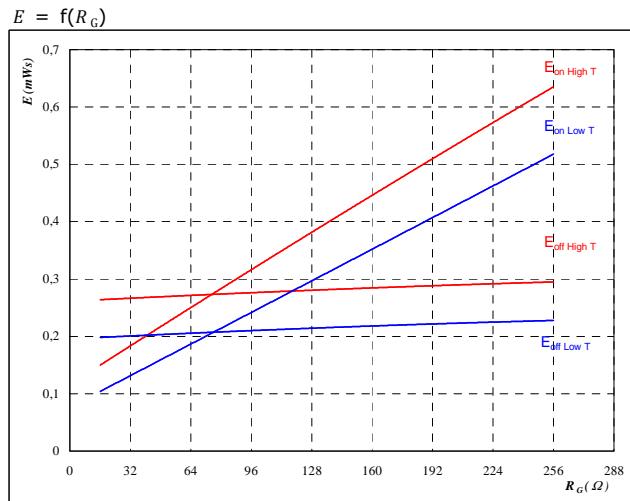
Figure 5
Typical switching energy losses
as a function of collector current



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 64 \Omega$
 $R_{goff} = 64 \Omega$

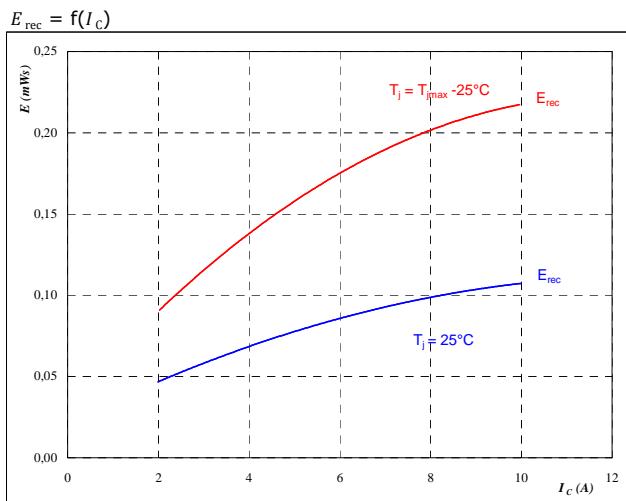
Figure 6
Typical switching energy losses
as a function of gate resistor



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 6 \text{ A}$

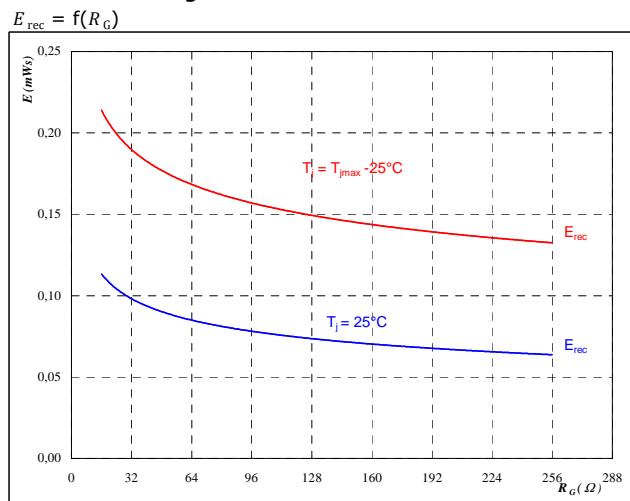
Figure 7
Typical reverse recovery energy loss
as a function of collector current



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 64 \Omega$

Figure 8
Typical reverse recovery energy loss
as a function of gate resistor



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 6 \text{ A}$



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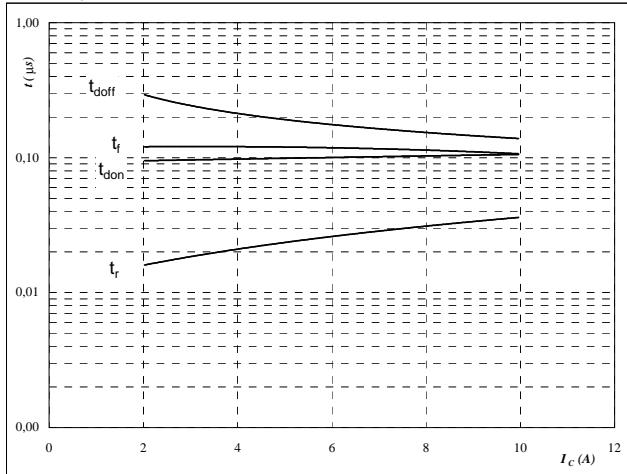
Inverter Characteristics

Figure 9

Inverter IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$



With an inductive load at

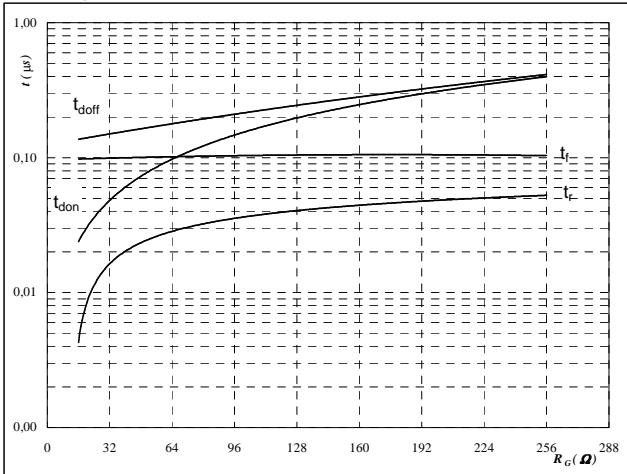
T _j =	125	°C
V _{CE} =	400	V
V _{GE} =	±15	V
R _{gon} =	64	Ω
R _{goff} =	64	Ω

Figure 10

Inverter IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



With an inductive load at

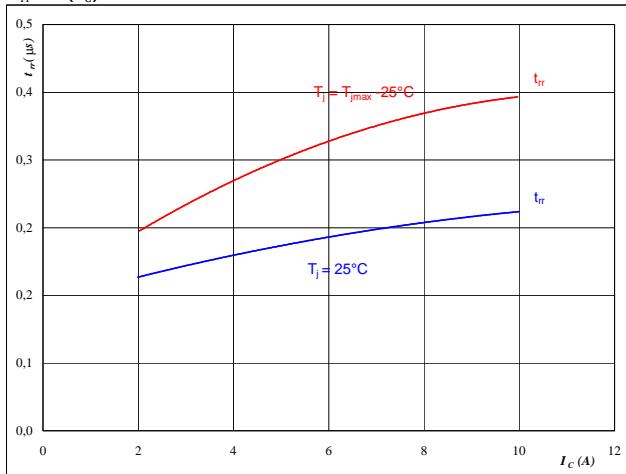
T _j =	125	°C
V _{CE} =	400	V
V _{GE} =	±15	V
I _C =	6	A

Figure 11

Inverter Diode

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$



At

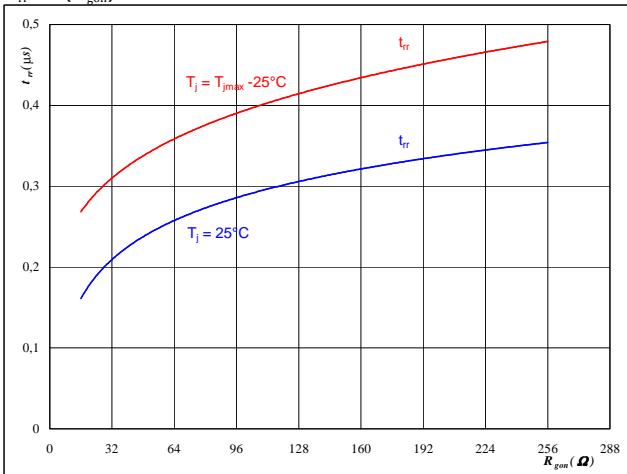
T _j =	25/125	°C
V _{CE} =	400	V
V _{GE} =	±15	V
R _{gon} =	64	Ω

Figure 12

Inverter Diode

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

T _j =	25/125	°C
V _R =	400	V
I _F =	6	A
V _{GE} =	±15	V



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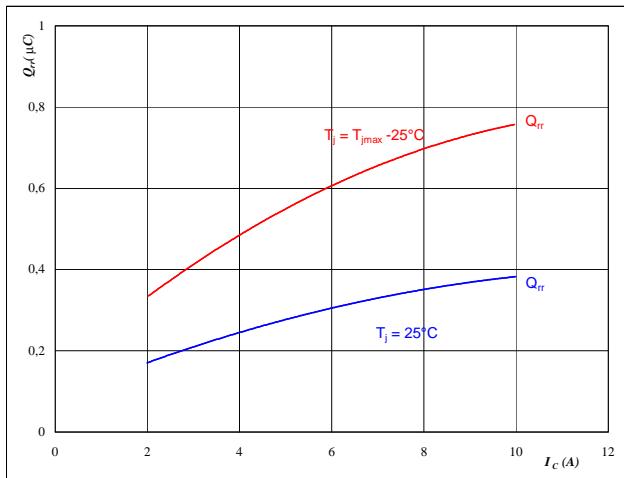
Inverter Characteristics

Figure 13

Inverter Diode

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

**At**

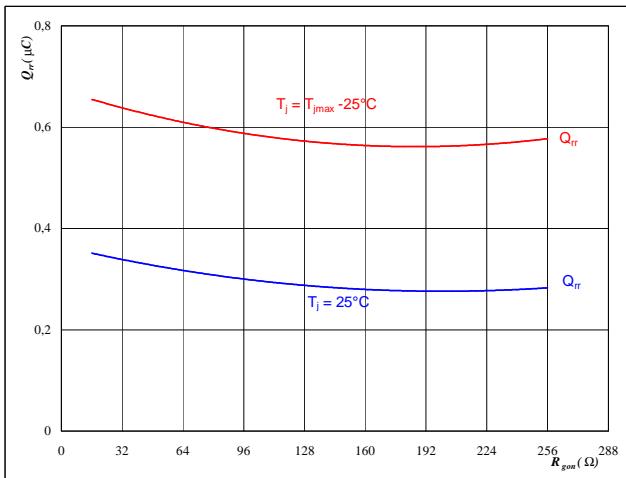
$T_j = 25/125 \quad ^\circ C$
 $V_{CE} = 400 \quad V$
 $V_{GE} = \pm 15 \quad V$
 $R_{gon} = 64 \quad \Omega$

Figure 14

Inverter Diode

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

**At**

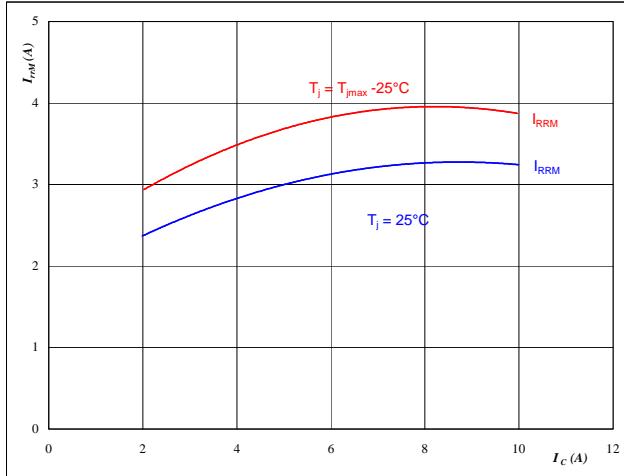
$T_j = 25/125 \quad ^\circ C$
 $V_R = 400 \quad V$
 $I_F = 6 \quad A$
 $V_{GE} = \pm 15 \quad V$

Figure 15

Inverter Diode

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

**At**

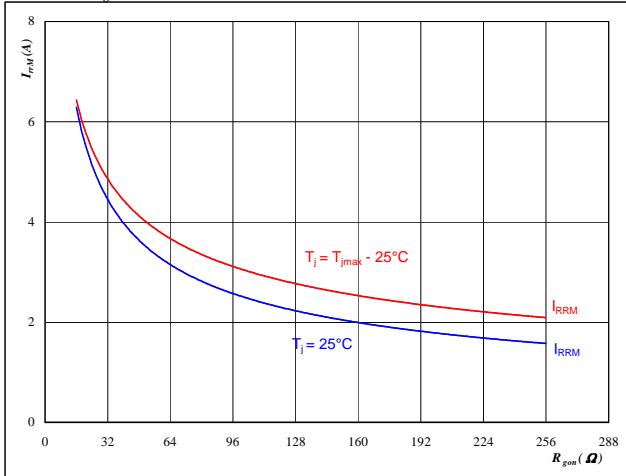
$T_j = 25/125 \quad ^\circ C$
 $V_{CE} = 400 \quad V$
 $V_{GE} = \pm 15 \quad V$
 $R_{gon} = 64 \quad \Omega$

Figure 16

Inverter Diode

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

**At**

$T_j = 25/125 \quad ^\circ C$
 $V_R = 400 \quad V$
 $I_F = 6 \quad A$
 $V_{GE} = \pm 15 \quad V$



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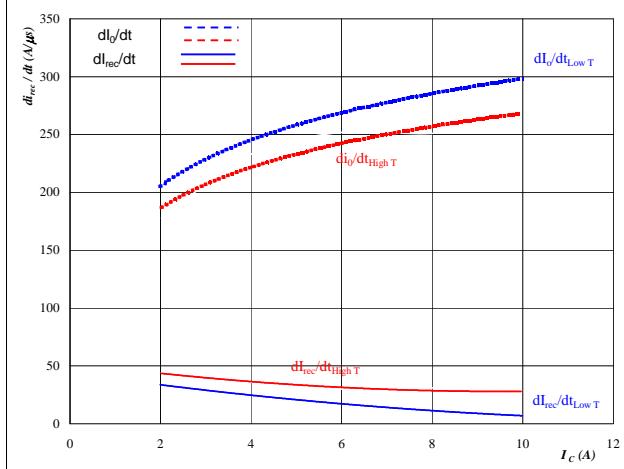
Inverter Characteristics

Figure 17

Inverter Diode

**Typical rate of fall of forward
and reverse recovery current as a
function of collector current**

$$dI_0/dt, dI_{rec}/dt = f(I_c)$$

**At**

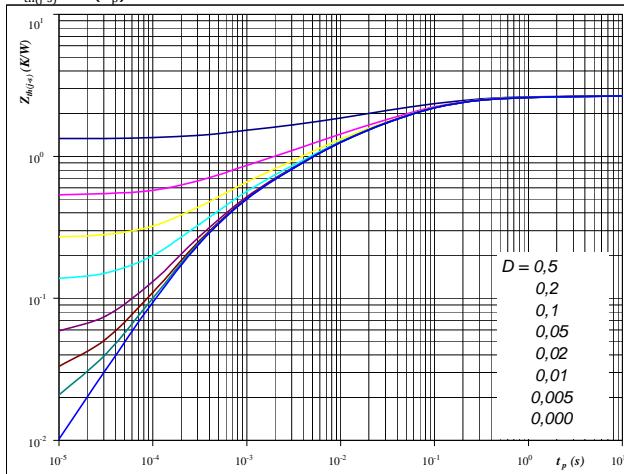
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 400 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 64 \quad \Omega \end{aligned}$$

Figure 19

Inverter IGBT

**IGBT transient thermal impedance
as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 2,66 \quad \text{K/W} \end{aligned}$$

IGBT thermal model values

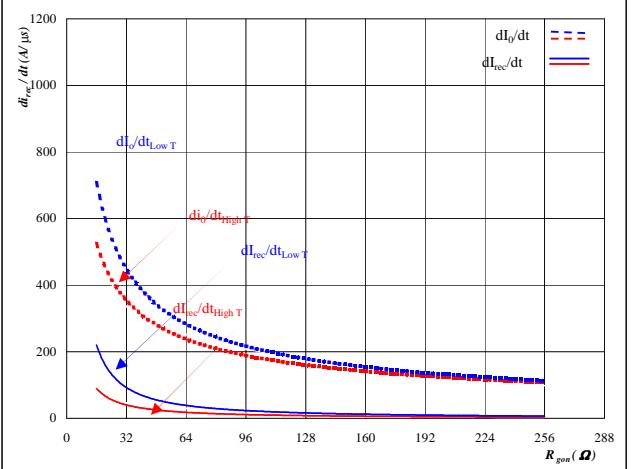
R (K/W)	Tau (s)
1,12E-01	1,79E+00
4,34E-01	1,79E-01
8,19E-01	4,95E-02
6,08E-01	9,45E-03
3,80E-01	2,26E-03
3,08E-01	3,96E-04

Figure 18

Inverter Diode

**Typical rate of fall of forward
and reverse recovery current as a
function of IGBT turn on gate resistor**

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

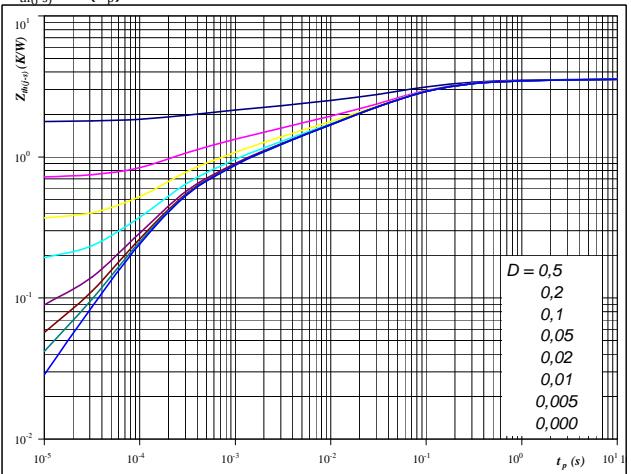
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_R &= 400 \quad \text{V} \\ I_F &= 6 \quad \text{A} \\ V_{GE} &= \pm 15 \quad \text{V} \end{aligned}$$

Figure 20

Inverter Diode

**FWD transient thermal impedance
as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 3,55 \quad \text{K/W} \end{aligned}$$

FWD thermal model values

R (K/W)	Tau (s)
1,62E-01	1,97E+00
7,21E-01	1,62E-01
1,17E+00	3,94E-02
5,18E-01	6,69E-03
4,51E-01	1,33E-03
5,35E-01	2,17E-04



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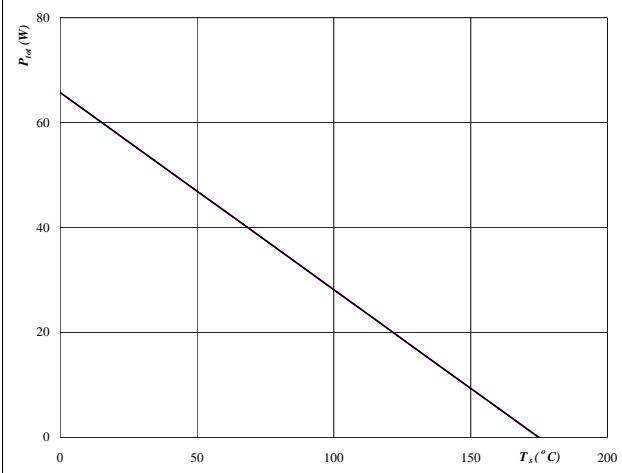
Inverter Characteristics

Figure 21

Inverter IGBT

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_s)$$

**At**

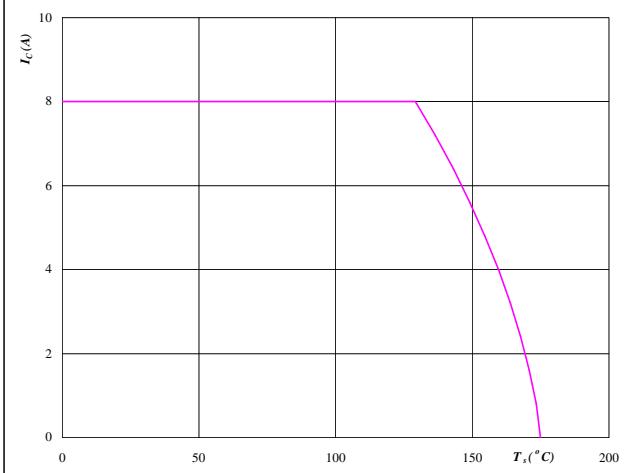
$$T_j = 175 \quad {}^{\circ}\text{C}$$

Figure 22

Inverter IGBT

Collector current as a function of heatsink temperature

$$I_C = f(T_s)$$

**At**

$$T_j = 175 \quad {}^{\circ}\text{C}$$

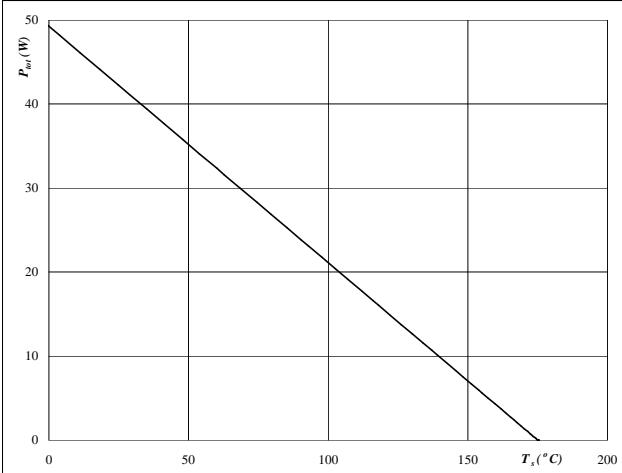
$$V_{GE} = 15 \quad \text{V}$$

Figure 23

Inverter Diode

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_s)$$

**At**

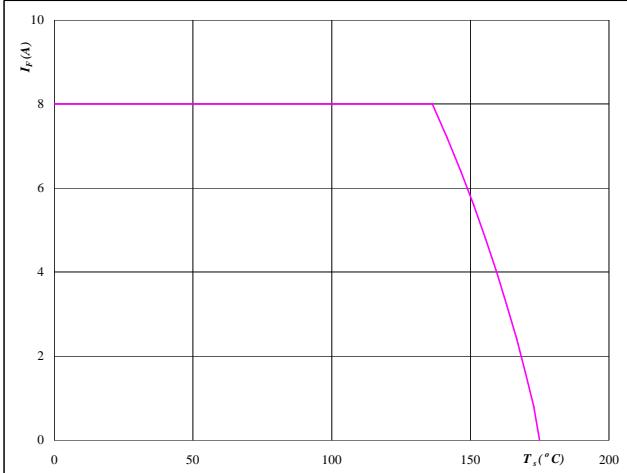
$$T_j = 175 \quad {}^{\circ}\text{C}$$

Figure 24

Inverter Diode

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$

**At**

$$T_j = 175 \quad {}^{\circ}\text{C}$$



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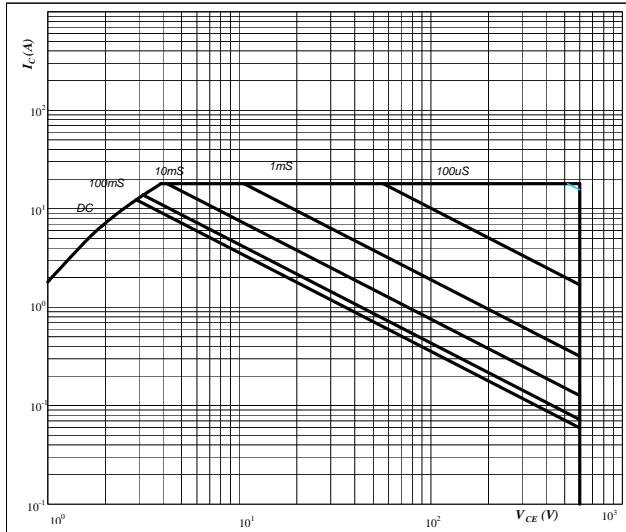
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datasheet

Inverter Characteristics

Figure 25
Safe operating area as a function
of collector-emitter voltage

$$I_C = f(V_{CE})$$

**At** $D =$ single pulse $T_s =$ 80 °C $V_{GE} = \pm 15$ V $T_j = T_{jmax}$

Inverter IGBT

Figure 26
Gate voltage vs Gate charge

$$V_{GE} = f(Q_g)$$

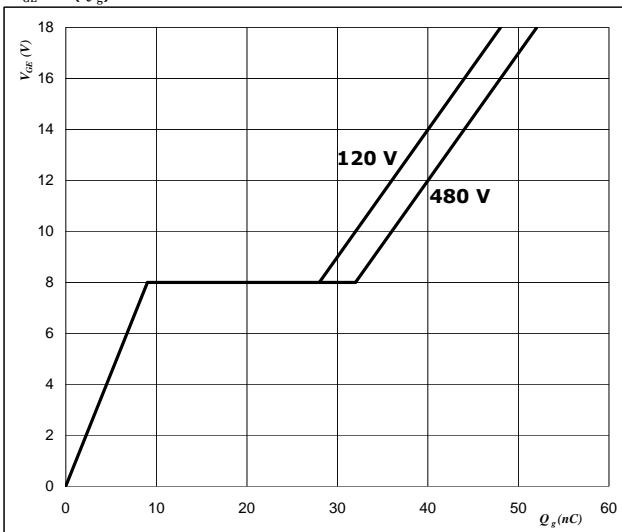
**At** $I_C = 6$ A

Figure 27
Short circuit withstand time as a function of
gate-emitter voltage

$$t_{sc} = f(V_{GE})$$

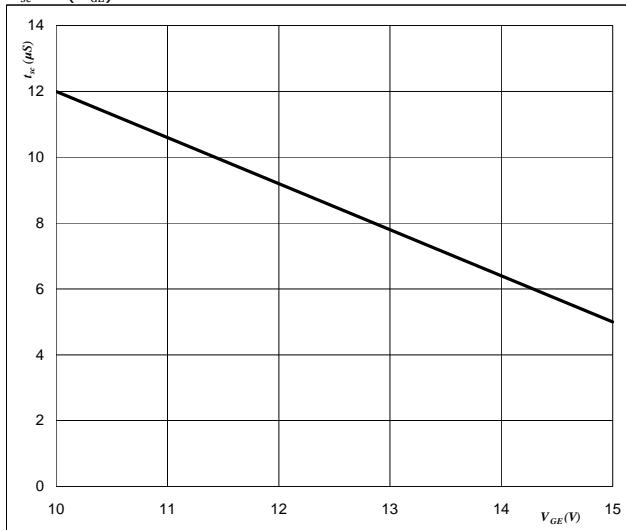
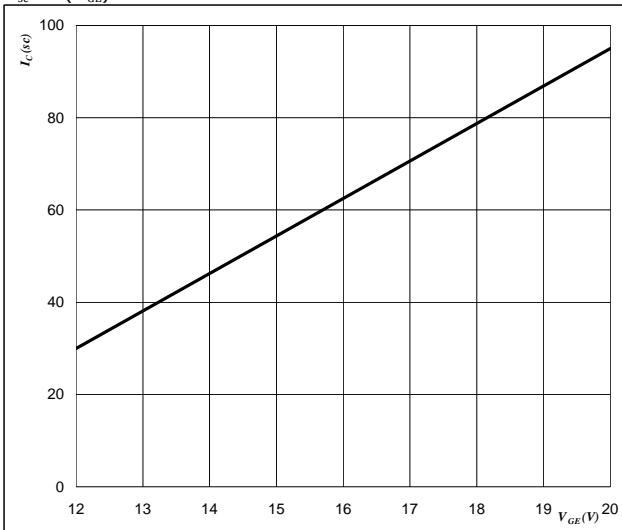
**At** $V_{CE} = 600$ V $T_j \leq 175$ °C

Figure 28
Typical short circuit collector current as a function of
gate-emitter voltage

$$I_{sc} = f(V_{GE})$$

**At** $V_{CE} \leq 600$ V $T_j = 175$ °C



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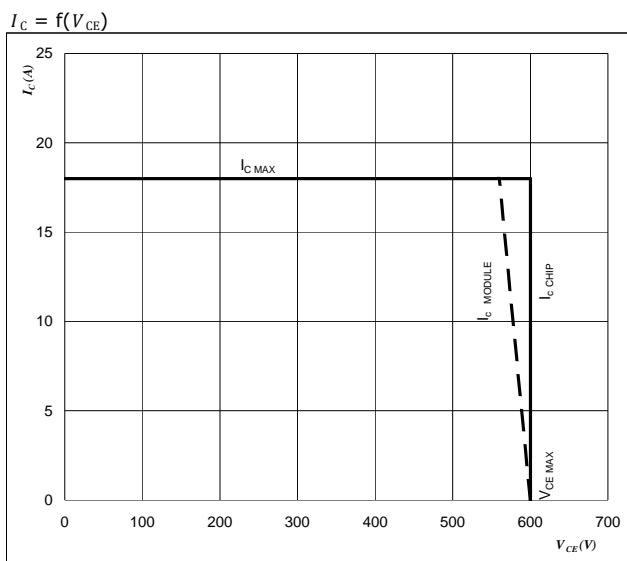
datasheet

Inverter Characteristics

Figure 29

IGBT

Reverse bias safe operating area



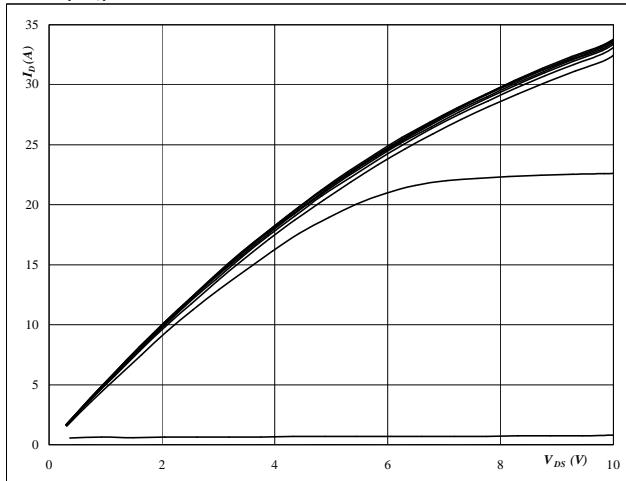
At

$T_j = T_{jmax} - 25 \text{ } ^\circ\text{C}$

PFC Characteristics

Figure 1**Typical output characteristics**

$I_D = f(V_{DS})$

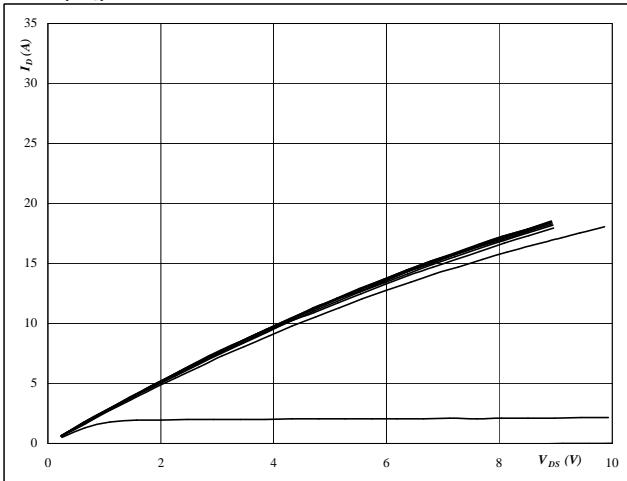
**At**

$t_p = 250 \mu\text{s}$

$T_j = 25^\circ\text{C}$

 V_{GS} from 0 V to 20 V in steps of 2 V**PFC MOSFET****Figure 2****Typical output characteristics**

$I_D = f(V_{DS})$

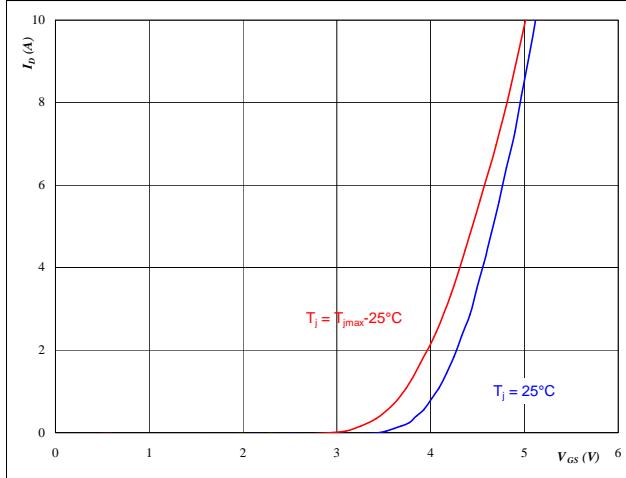
**At**

$t_p = 250 \mu\text{s}$

$T_j = 125^\circ\text{C}$

 V_{GS} from 0 V to 20 V in steps of 2 V**Figure 3****Typical transfer characteristics**

$I_D = f(V_{GS})$

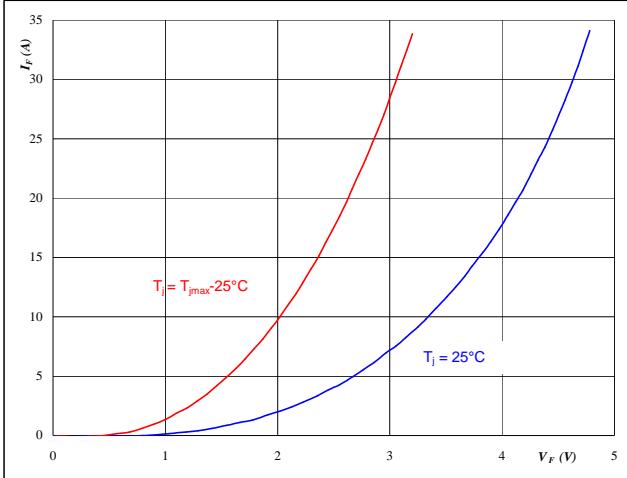
**At**

$t_p = 250 \mu\text{s}$

$V_{DS} = 10 \text{ V}$

PFC MOSFET**Figure 4****Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$

**At**

$t_p = 250 \mu\text{s}$



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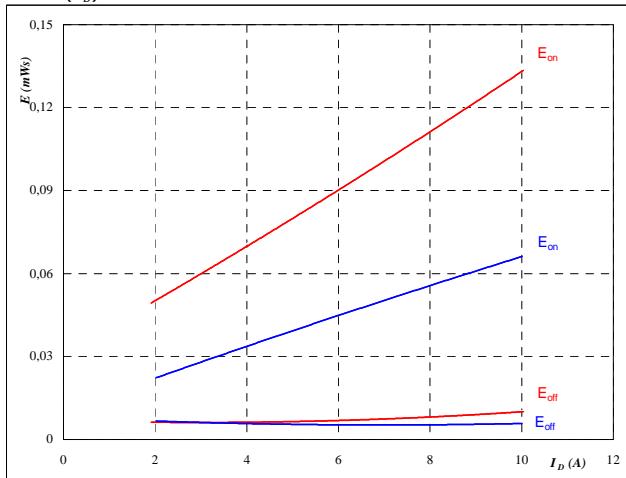
PFC Characteristics

Figure 5

PFC MOSFET

**Typical switching energy losses
as a function of drain current**

$$E = f(I_D)$$



With an inductive load at

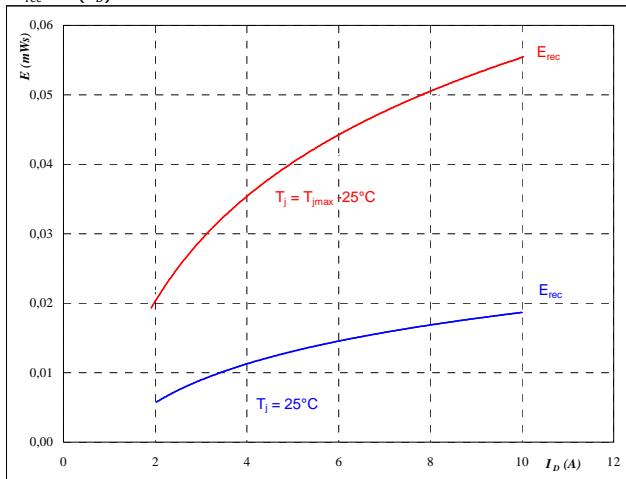
T_j = 25/125 °C
V_{DS} = 400 V
V_{GS} = 10 V
R_{gon} = 4 Ω
R_{goff} = 4 Ω

Figure 7

PFC MOSFET

**Typical reverse recovery energy loss
as a function of drain current**

$$E_{rec} = f(I_D)$$



With an inductive load at

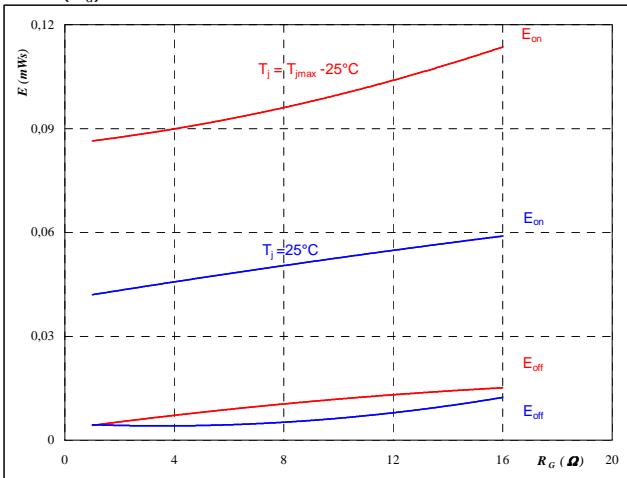
T_j = 25/125 °C
V_{DS} = 400 V
V_{GS} = 10 V
R_{gon} = 4 Ω
R_{goff} = 4 Ω

Figure 6

PFC MOSFET

**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

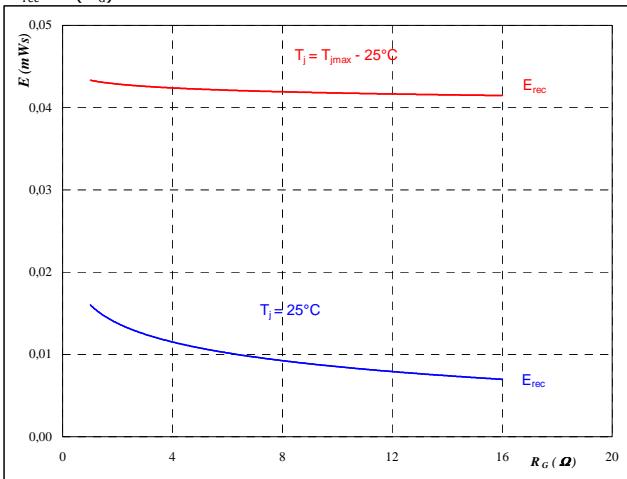
T_j = 25/125 °C
V_{DS} = 400 V
V_{GS} = 10 V
I_D = 6 A

Figure 8

PFC MOSFET

**Typical reverse recovery energy loss
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

T_j = 25/125 °C
V_{DS} = 400 V
V_{GS} = 10 V
I_D = 6 A



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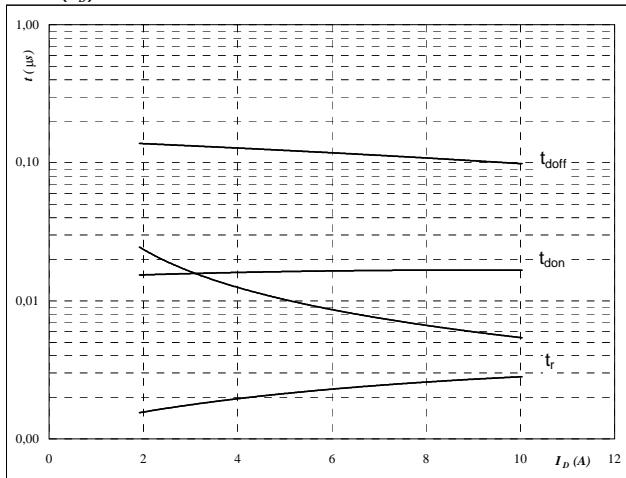
PFC Characteristics

Figure 9

PFC MOSFET

Typical switching times as a function of drain current

$$t = f(I_D)$$



With an inductive load at

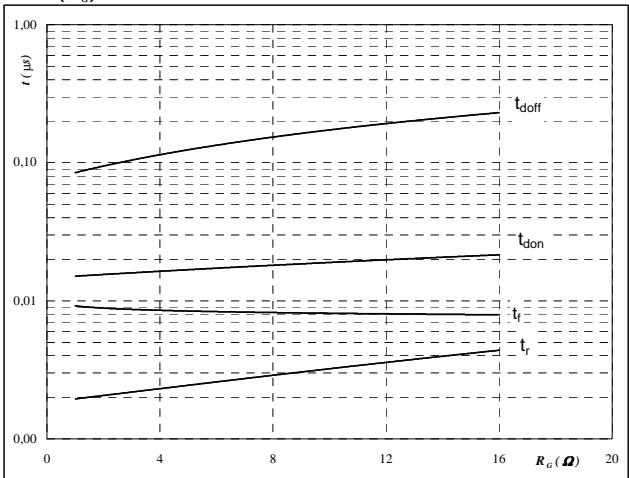
$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 10 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \\ R_{goff} &= 4 \quad \Omega \end{aligned}$$

Figure 10

PFC MOSFET

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



With an inductive load at

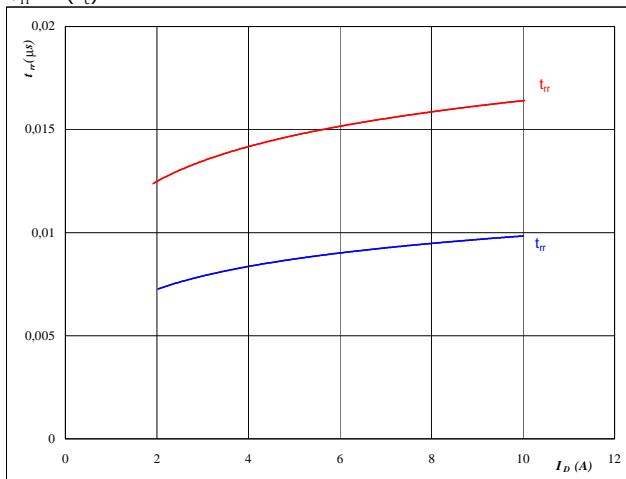
$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 10 \quad \text{V} \\ I_D &= 6 \quad \text{A} \end{aligned}$$

Figure 11

PFC Diode

Typical reverse recovery time as a function of drain current

$$t_{rr} = f(I_d)$$



At

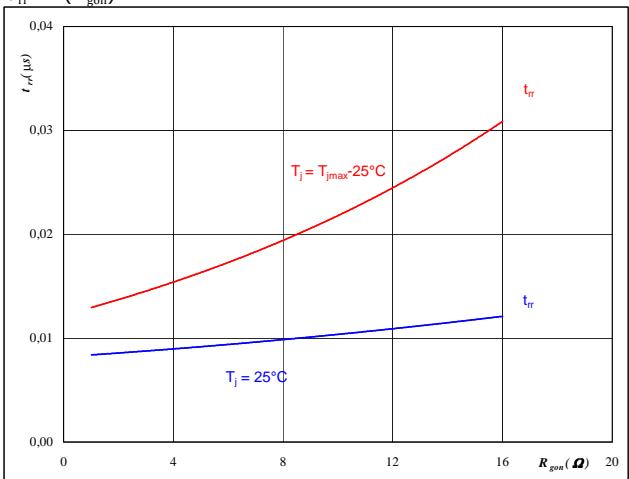
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 400 \quad \text{V} \\ V_{GE} &= 10 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

Figure 12

PFC Diode

Typical reverse recovery time as a function of MOSFET turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_R &= 400 \quad \text{V} \\ I_F &= 6 \quad \text{A} \\ V_{GS} &= 10 \quad \text{V} \end{aligned}$$



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datasheet

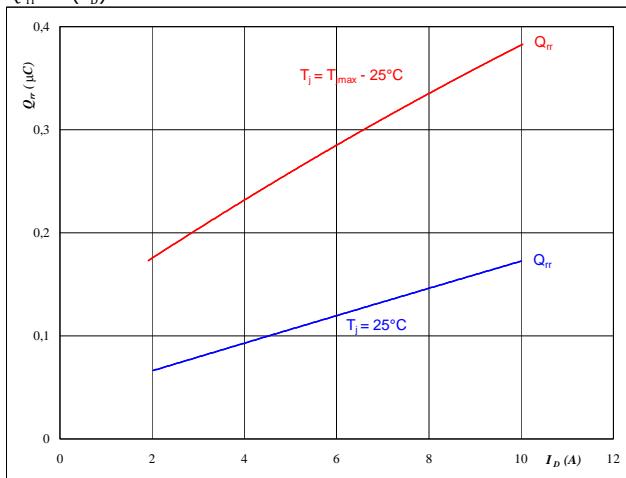
PFC Characteristics

Figure 13

PFC Diode

Typical reverse recovery charge as a function of drain current

$$Q_{rr} = f(I_D)$$

**At**

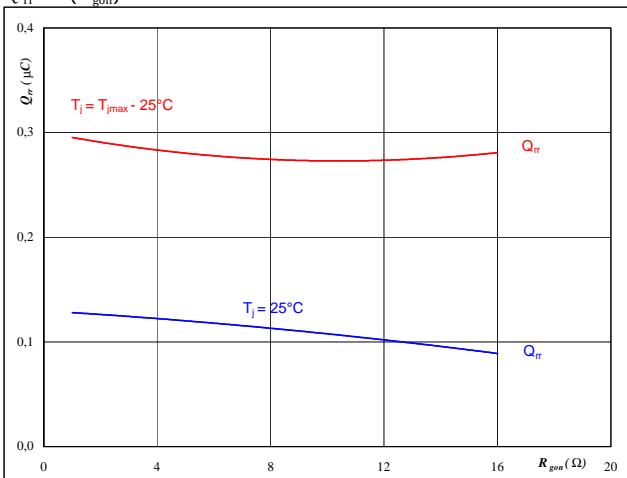
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 10 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

Figure 14

PFC Diode

Typical reverse recovery charge as a function of MOSFET turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

**At**

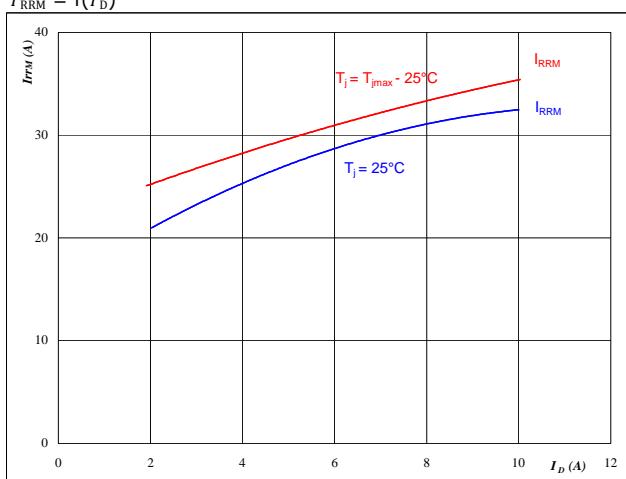
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_R &= 400 \quad \text{V} \\ I_F &= 6 \quad \text{A} \\ V_{GS} &= 10 \quad \text{V} \end{aligned}$$

Figure 15

PFC Diode

Typical reverse recovery current as a function of drain current

$$I_{RRM} = f(I_D)$$

**At**

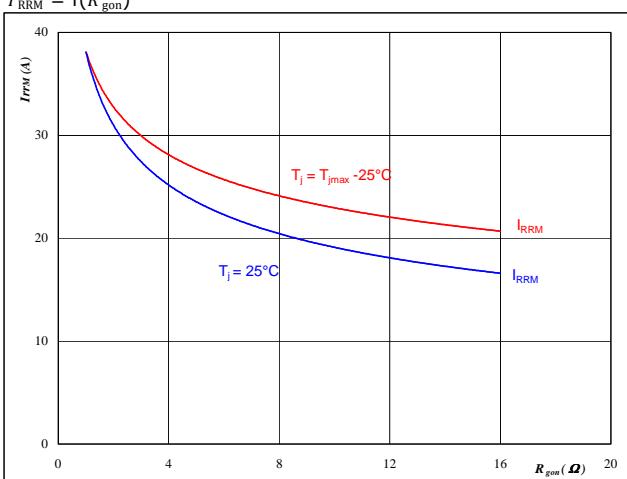
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 10 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

Figure 16

PFC Diode

Typical reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

**At**

$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_R &= 400 \quad \text{V} \\ I_F &= 6 \quad \text{A} \\ V_{GS} &= 10 \quad \text{V} \end{aligned}$$



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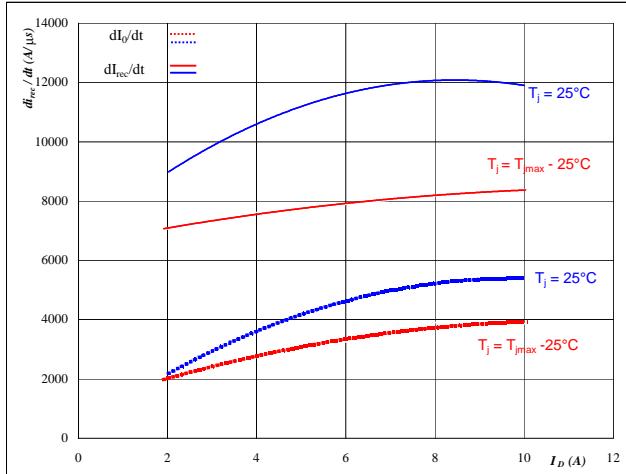
PFC Characteristics

Figure 17

PFC Diode

Typical rate of fall of forward and reverse recovery current as a function of drain current

$$dI_0/dt, dI_{rec}/dt = f(I_D)$$

**At**

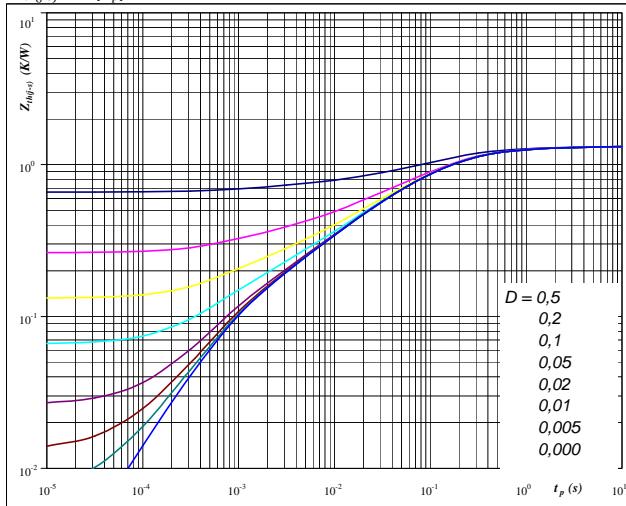
$T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 10 \text{ V}$
 $R_{gon} = 4 \Omega$

Figure 19

PFC MOSFET

MOSFET transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

$D = t_p / T$
 $R_{th(j-s)} = 1,32 \text{ K/W}$

IGBT thermal model values

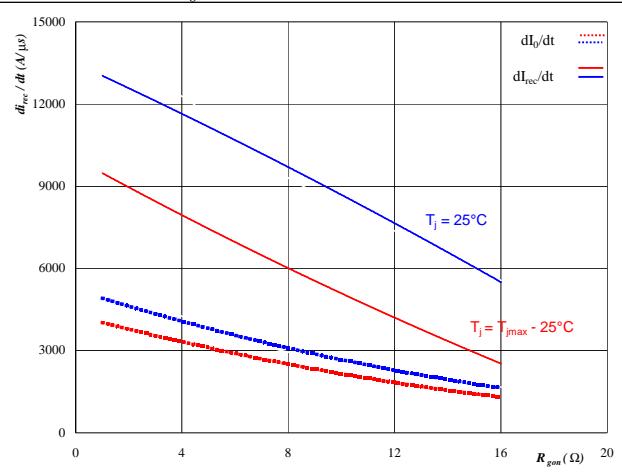
R (K/W)	Tau (s)
6,07E-02	2,94E+00
1,82E-01	4,56E-01
5,66E-01	1,17E-01
2,74E-01	2,61E-02
1,33E-01	6,31E-03
9,91E-02	8,98E-04

Figure 18

PFC Diode

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

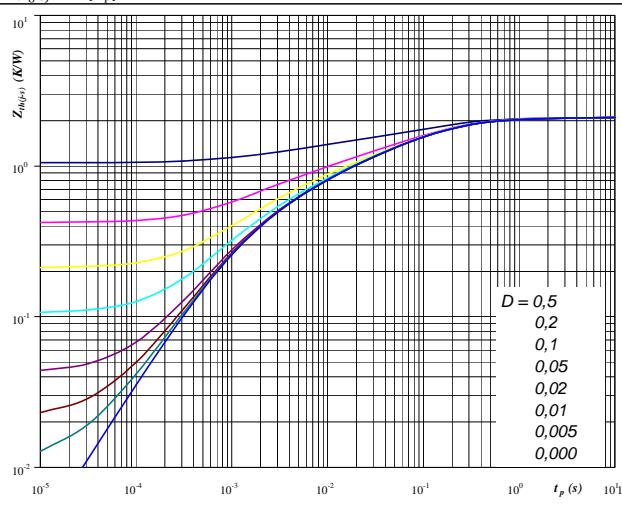
$T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_R = 400 \text{ V}$
 $I_F = 6 \text{ A}$
 $V_{GS} = 10 \text{ V}$

Figure 19

PFC Diode

FWD transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

$D = t_p / T$
 $R_{th(j-s)} = 2,10 \text{ K/W}$

FWD thermal model values

R (K/W)	Tau (s)
7,54E-02	2,95E+00
3,60E-01	3,15E-01
7,40E-01	7,85E-02
4,10E-01	1,41E-02
3,24E-01	3,24E-03
1,92E-01	8,47E-04



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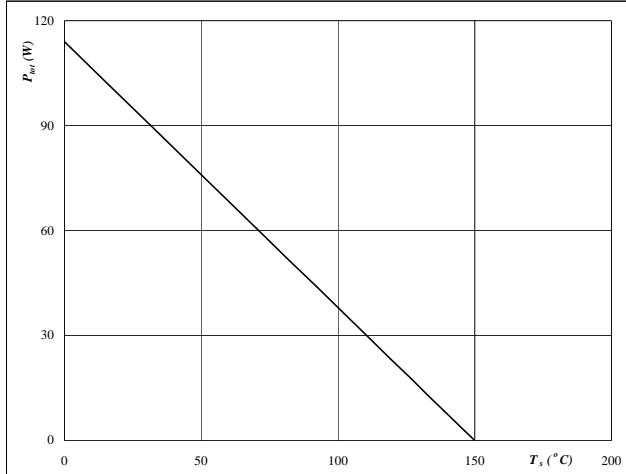
PFC Characteristics

Figure 21

PFC MOSFET

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_s)$$

**At**

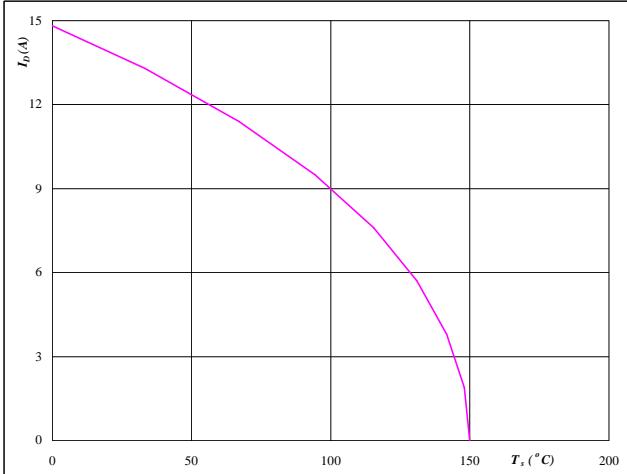
$$T_j = 150 \quad ^\circ\text{C}$$

Figure 22

PFC MOSFET

Drain current as a function of heatsink temperature

$$I_D = f(T_s)$$

**At**

$$T_j = 150 \quad ^\circ\text{C}$$

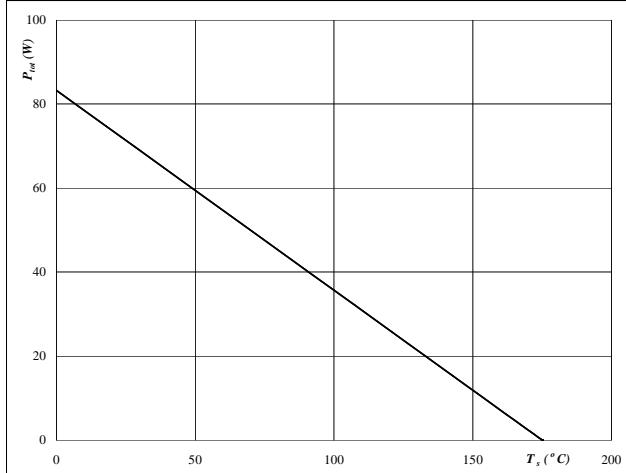
$$V_{GS} = 10 \quad \text{V}$$

Figure 23

PFC Diode

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_s)$$

**At**

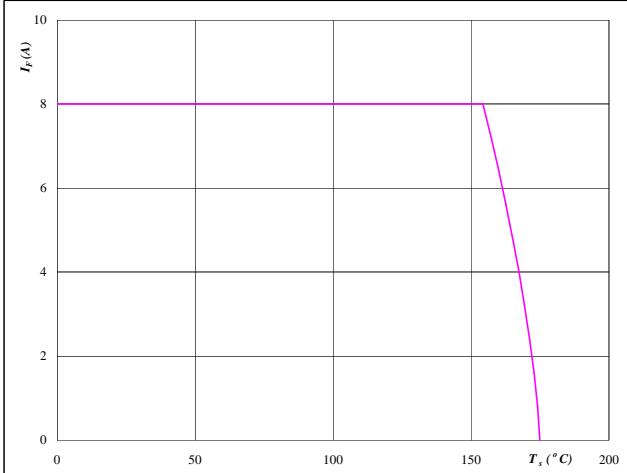
$$T_j = 175 \quad ^\circ\text{C}$$

Figure 24

PFC Diode

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$

**At**

$$T_j = 175 \quad ^\circ\text{C}$$



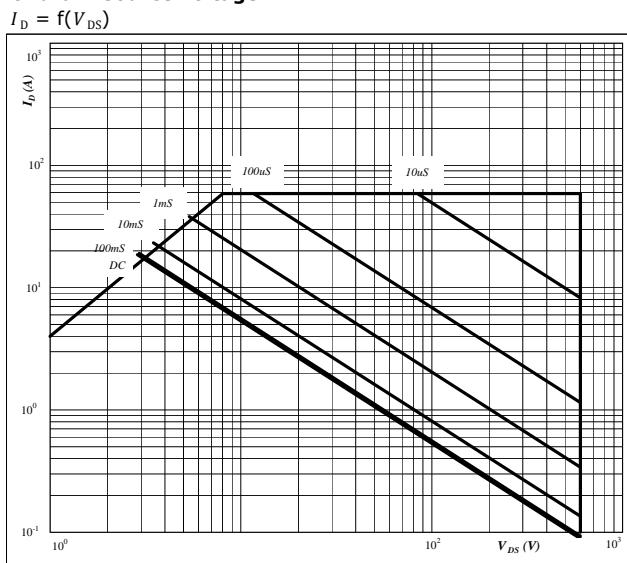
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datasheet

PFC Characteristics

Figure 25
Safe operating area as a function
of drain-source voltage

**At** $D =$ single pulse $T_s =$ 80 °C $V_{GS} =$ 10 V $T_j = T_{jmax}$ °C

PFC MOSFET

Figure 26
Gate voltage vs Gate charge

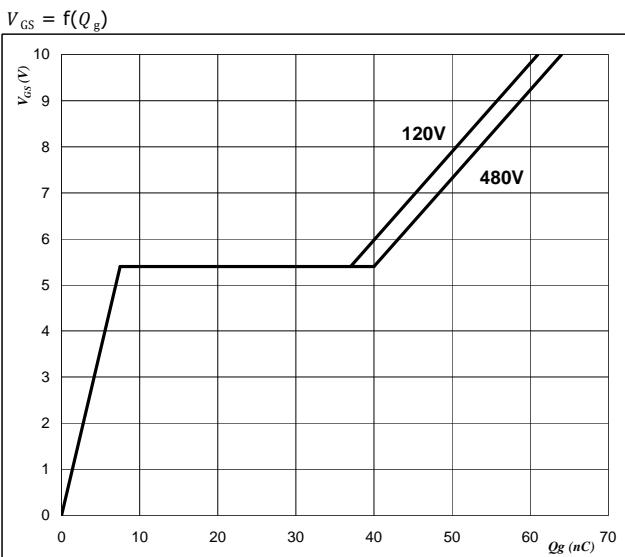
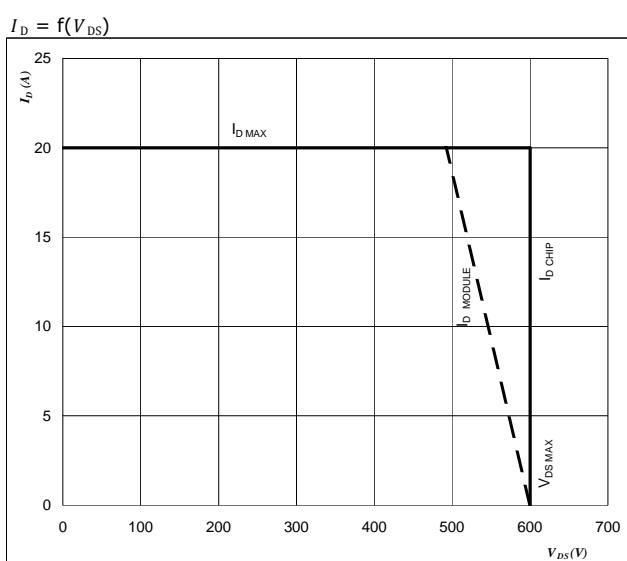
**At** $I_D =$ 6 A

Figure 29
Reverse bias safe operating area

**At** $T_j = T_{jmax}-25$ °C



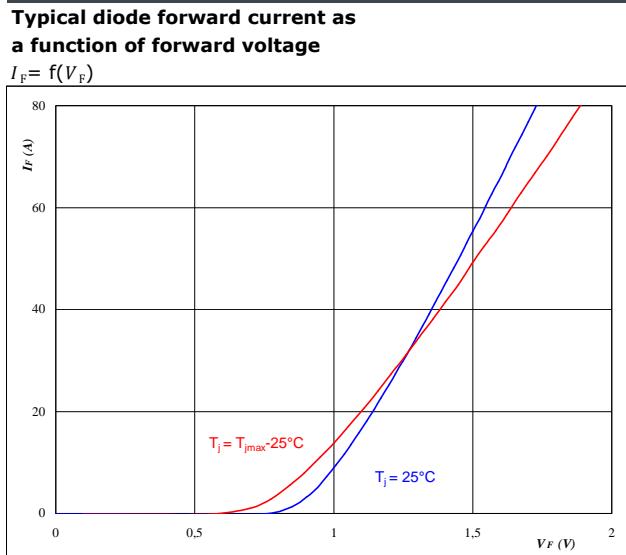
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datasheet

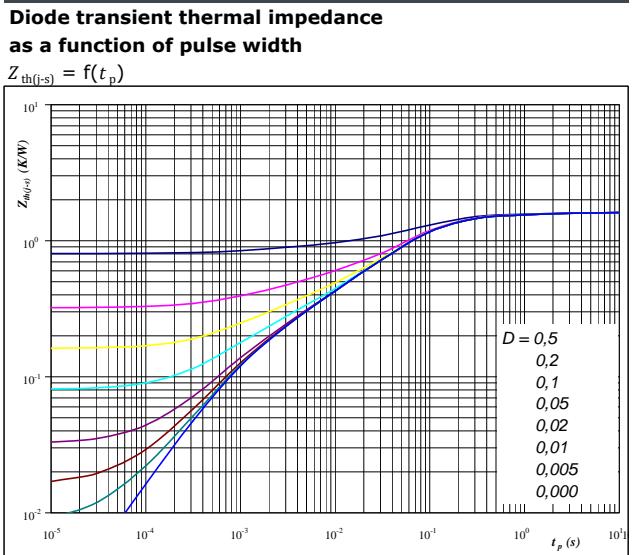
Rectifier Characteristics

Figure 1 Rectifier Diode
Typical diode forward current as a function of forward voltage



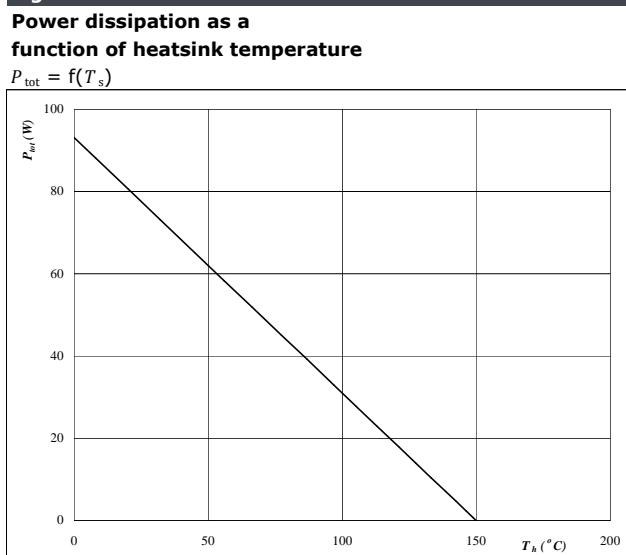
At
 $t_p = 250 \mu\text{s}$

Figure 2 Rectifier Diode
Diode transient thermal impedance as a function of pulse width



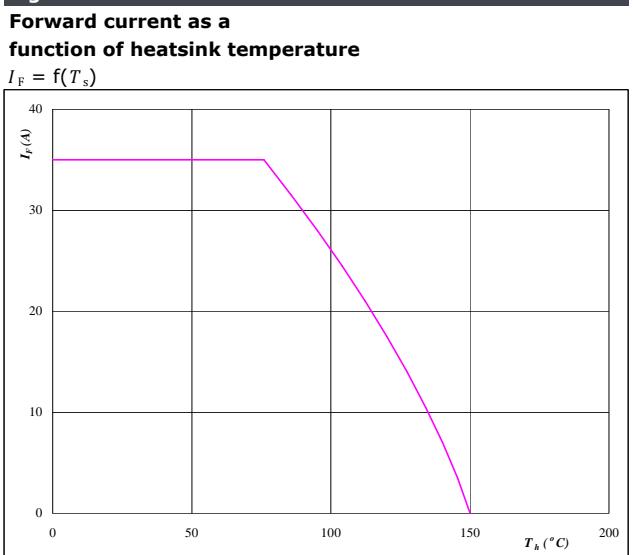
At
 $D = t_p / T$
 $R_{th(j-s)} = 1,61 \text{ K/W}$

Figure 3 Rectifier Diode
Power dissipation as a function of heatsink temperature



At
 $T_j = 150 \text{ }^{\circ}\text{C}$

Figure 4 Rectifier Diode
Forward current as a function of heatsink temperature



At
 $T_j = 150 \text{ }^{\circ}\text{C}$

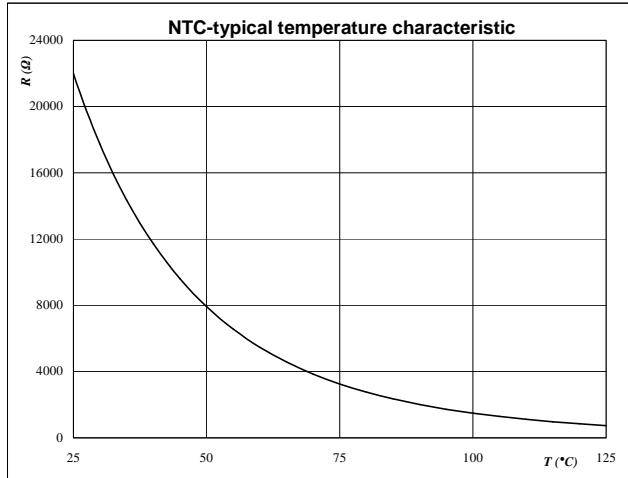
Thermistor Characteristics

Figure 1

Thermistor

**Typical NTC characteristic
as a function of temperature**

$$R_T = f(T)$$



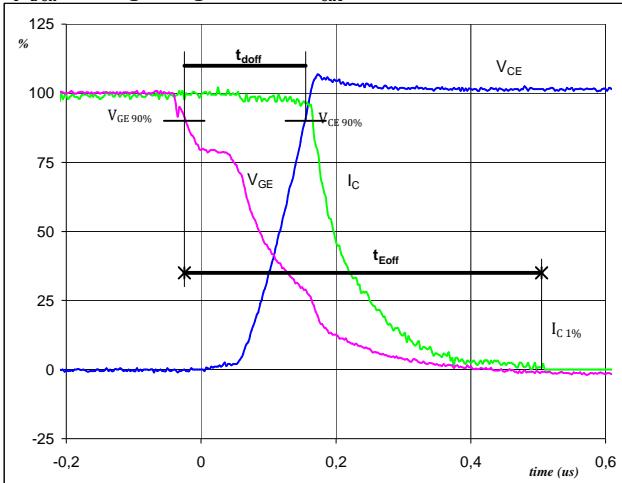
Switching Definitions Inverter

General conditions

T_j	= 125 °C
R_{gon}	= 64 Ω
R_{goff}	= 64 Ω

Figure 1 Inverter IGBT

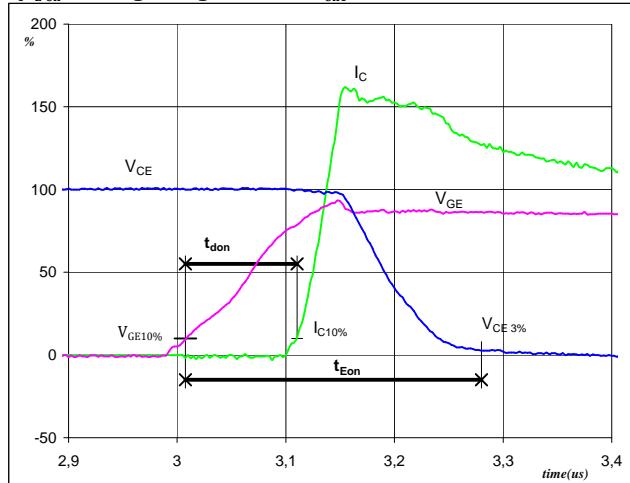
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
(t_{Eoff} = integrating time for E_{off})



$V_{GE} (0\%) = -15 \text{ V}$
 $V_{GE} (100\%) = 15 \text{ V}$
 $V_C (100\%) = 400 \text{ V}$
 $I_C (100\%) = 6 \text{ A}$
 $t_{doff} = 0,18 \mu\text{s}$
 $t_{Eoff} = 0,53 \mu\text{s}$

Figure 2 Inverter IGBT

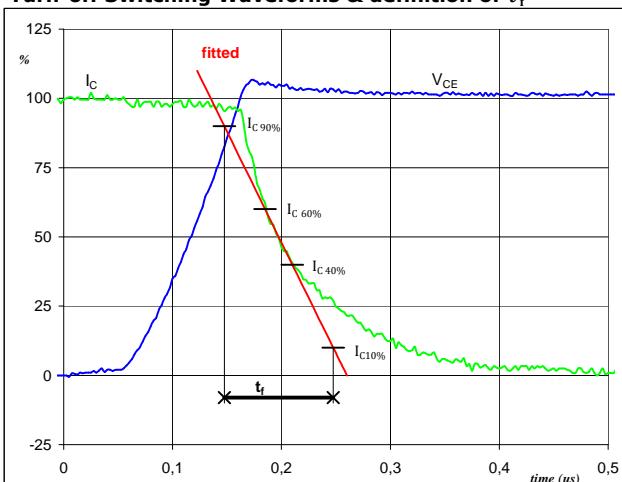
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
(t_{Eon} = integrating time for E_{on})



$V_{GE} (0\%) = -15 \text{ V}$
 $V_{GE} (100\%) = 15 \text{ V}$
 $V_C (100\%) = 400 \text{ V}$
 $I_C (100\%) = 6 \text{ A}$
 $t_{don} = 0,10 \mu\text{s}$
 $t_{Eon} = 0,27 \mu\text{s}$

Figure 3 Inverter IGBT

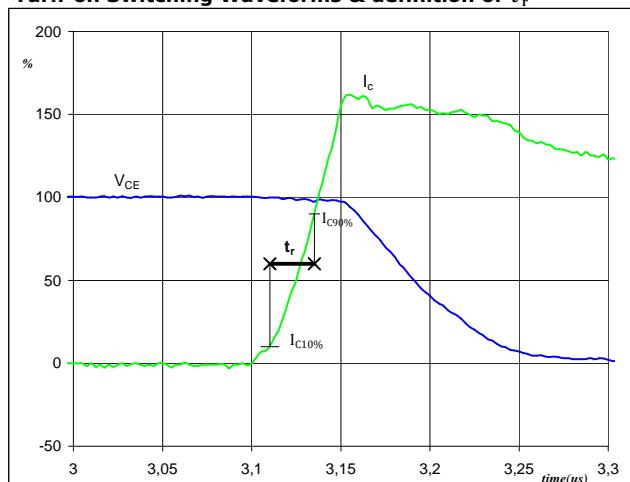
Turn-off Switching Waveforms & definition of t_f



$V_C (100\%) = 400 \text{ V}$
 $I_C (100\%) = 6 \text{ A}$
 $t_f = 0,11 \mu\text{s}$

Figure 4 Inverter IGBT

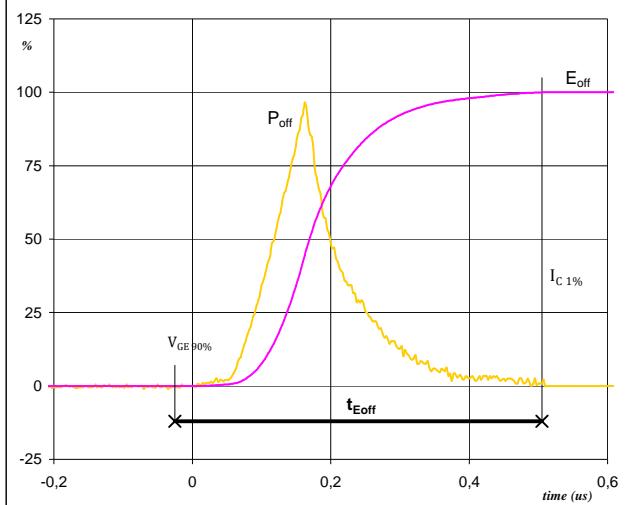
Turn-on Switching Waveforms & definition of t_r



$V_C (100\%) = 400 \text{ V}$
 $I_C (100\%) = 6 \text{ A}$
 $t_r = 0,03 \mu\text{s}$

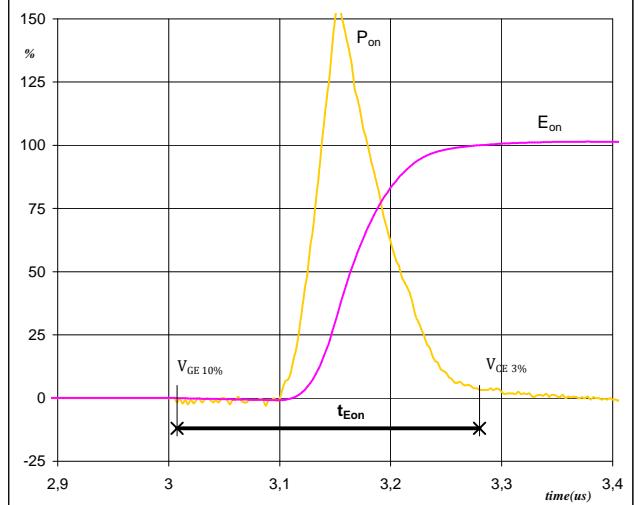
Switching Definitions Inverter

Figure 5 Inverter IGBT
Turn-off Switching Waveforms & definition of t_{Eoff}



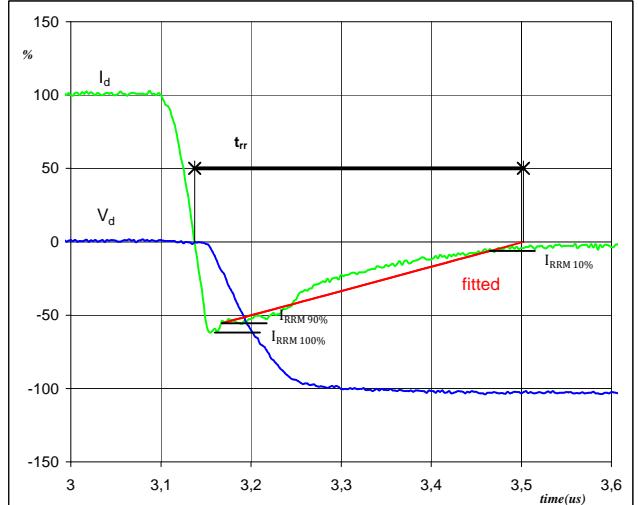
P_{off} (100%) = 2,41 kW
 E_{off} (100%) = 0,27 mJ
 t_{Eoff} = 0,53 μs

Figure 6 Inverter IGBT
Turn-on Switching Waveforms & definition of t_{Eon}



P_{on} (100%) = 2,41 kW
 E_{on} (100%) = 0,25 mJ
 t_{Eon} = 0,27 μs

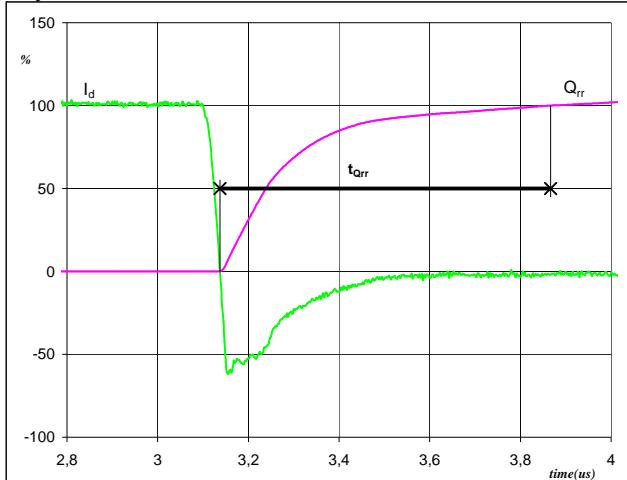
Figure 7 Inverter Diode
Turn-off Switching Waveforms & definition of t_{rr}



V_d (100%) = 400 V
 I_d (100%) = 6 A
 I_{RRM} (100%) = -4 A
 t_{rr} = 0,34 μs

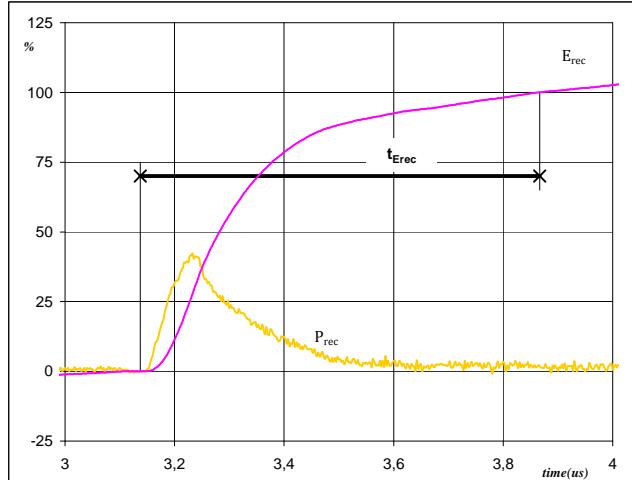
Switching Definitions Inverter

Figure 8 Inverter Diode
Turn-on Switching Waveforms & definition of $t_{Q_{rr}}$
 $(t_{Q_{rr}} = \text{integrating time for } Q_{rr})$



I_d (100%) = 6 A
 Q_{rr} (100%) = 0,60 μC
 $t_{Q_{rr}} =$ 0,73 μs

Figure 9 Inverter Diode
Turn-on Switching Waveforms & definition of $t_{E_{rec}}$
 $(t_{E_{rec}} = \text{integrating time for } E_{rec})$



P_{rec} (100%) = 2,41 kW
 E_{rec} (100%) = 0,17 mJ
 $t_{E_{rec}} =$ 0,73 μs



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Switching Definitions PFC

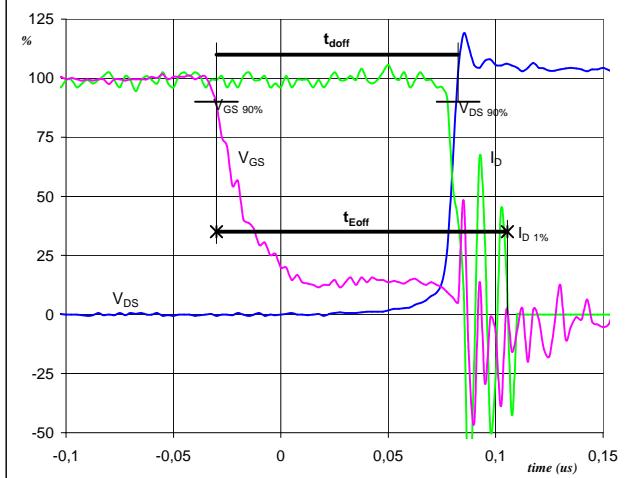
General conditions

T_j	= 125 °C
R_{gon}	= 4 Ω
R_{goff}	= 4 Ω

Figure 1

PFC MOSFET

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
(t_{Eoff} = integrating time for E_{off})

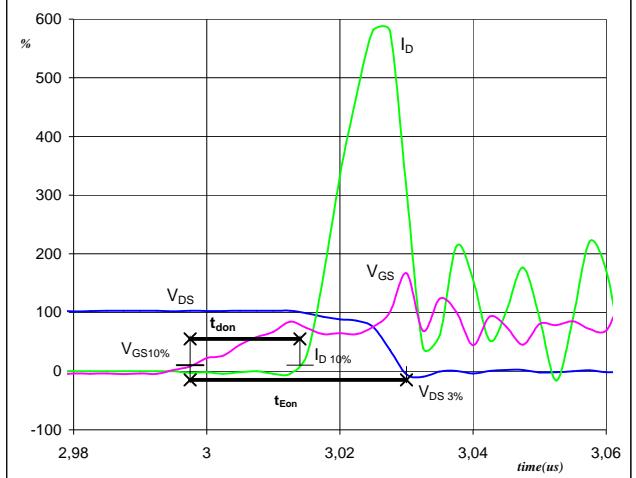


$V_{GS}(0\%) = 0 \text{ V}$
 $V_{GS}(100\%) = 10 \text{ V}$
 $V_D(100\%) = 400 \text{ V}$
 $I_D(100\%) = 6 \text{ A}$
 $t_{doff} = 0,11 \mu\text{s}$
 $t_{Eoff} = 0,14 \mu\text{s}$

Figure 2

PFC MOSFET

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
(t_{Eon} = integrating time for E_{on})

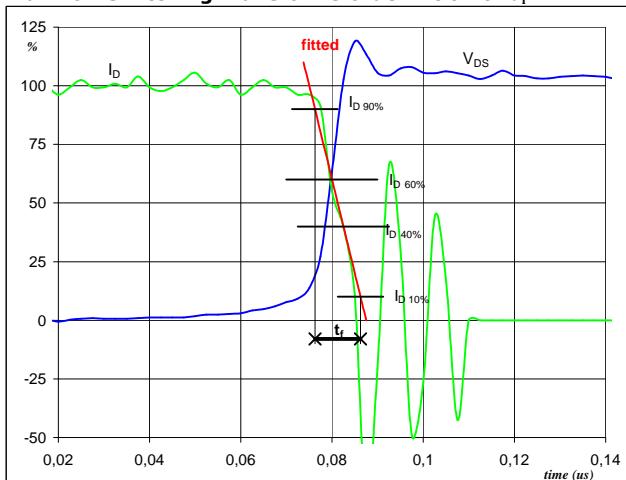


$V_{GS}(0\%) = 0 \text{ V}$
 $V_{GS}(100\%) = 10 \text{ V}$
 $V_D(100\%) = 400 \text{ V}$
 $I_D(100\%) = 6 \text{ A}$
 $t_{don} = 0,02 \mu\text{s}$
 $t_{Eon} = 0,03 \mu\text{s}$

Figure 3

PFC MOSFET

Turn-off Switching Waveforms & definition of t_f

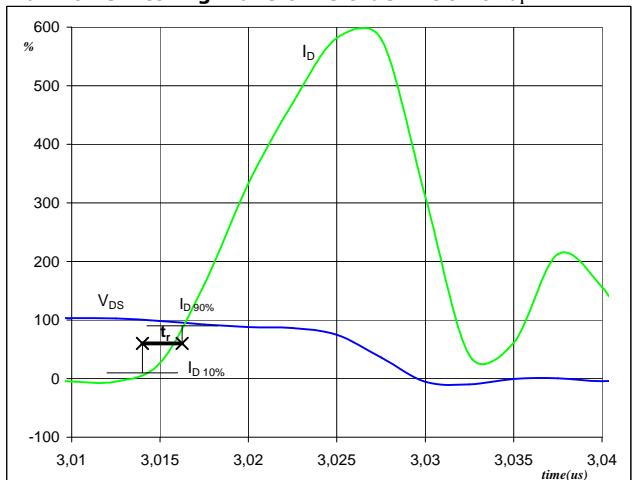


$V_D(100\%) = 400 \text{ V}$
 $I_D(100\%) = 6 \text{ A}$
 $t_f = 0,01 \mu\text{s}$

Figure 4

PFC MOSFET

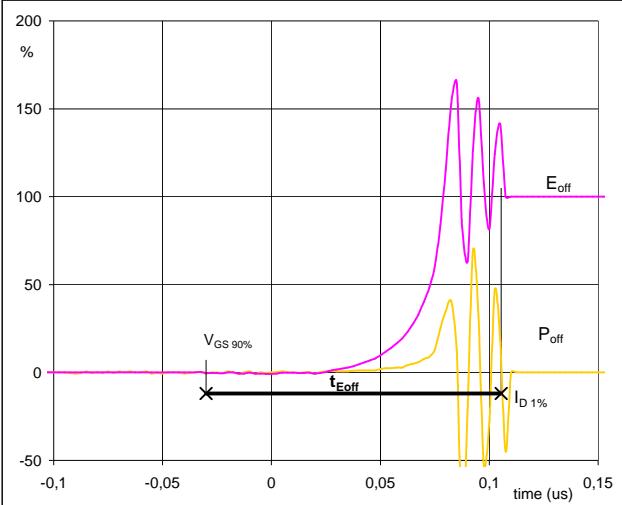
Turn-on Switching Waveforms & definition of t_r



$V_D(100\%) = 400 \text{ V}$
 $I_C(100\%) = 6 \text{ A}$
 $t_r = 0,002 \mu\text{s}$

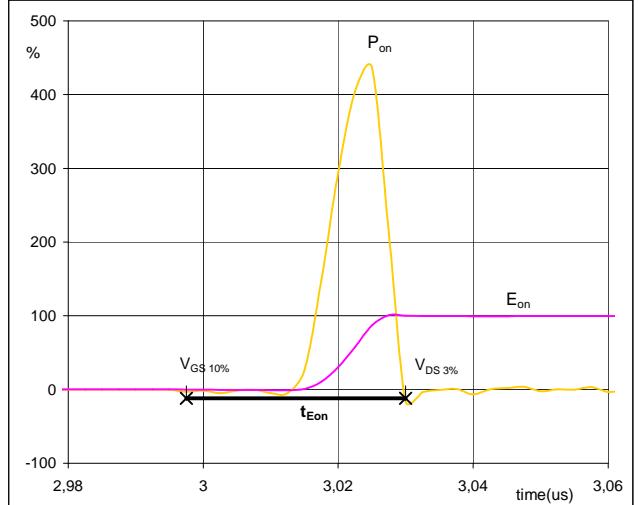
Switching Definitions PFC

Figure 5 PFC MOSFET
Turn-off Switching Waveforms & definition of t_{Eoff}



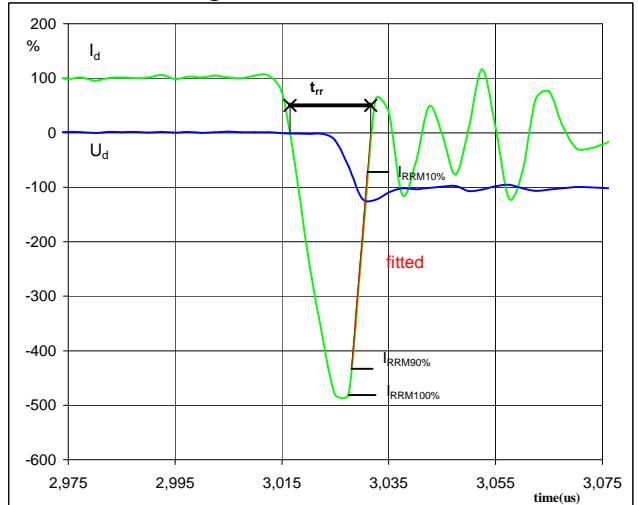
P_{off} (100%) = 2,45 kW
 E_{off} (100%) = 0,01 mJ
 $t_{E\,off}$ = 0,14 μ s

Figure 6 PFC MOSFET
Turn-on Switching Waveforms & definition of t_{Eon}



P_{on} (100%) = 2,45 kW
 E_{on} (100%) = 0,09 mJ
 $t_{E\,on}$ = 0,0325 μ s

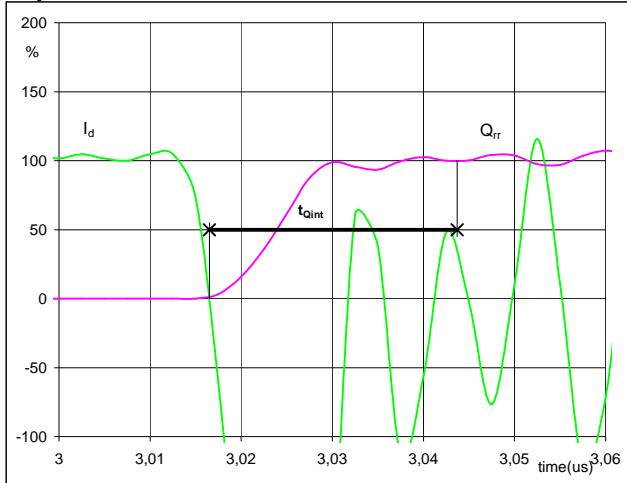
Figure 7 PFC Diode
Turn-off Switching Waveforms & definition of t_{rr}



V_d (100%) = 400 V
 I_d (100%) = 6 A
 I_{RRM} (100%) = -31 A
 t_{rr} = 0,02 μ s

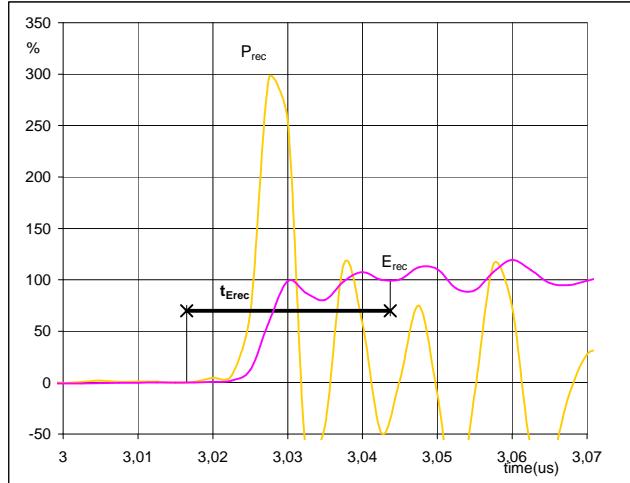
Switching Definitions PFC

Figure 8 PFC Diode
Turn-on Switching Waveforms & definition of t_{Qrr}
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$



I_d (100%) = 6 A
 Q_{rr} (100%) = 0,29 μC
 t_{Qint} = 0,03 μs

Figure 9 PFC Diode
Turn-on Switching Waveforms & definition of t_{Erec}
 $(t_{Erec} = \text{integrating time for } E_{rec})$



P_{rec} (100%) = 2,45 kW
 E_{rec} (100%) = 0,04 mJ
 t_{Erec} = 0,03 μs



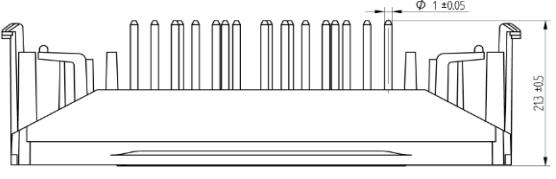
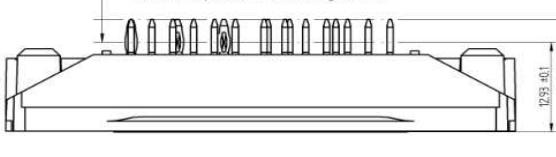
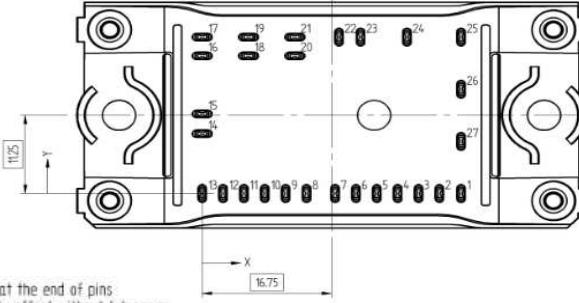
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Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking								
Version			Ordering Code					
without thermal paste 17mm housing with solder pins					10-F006PPA006SB-M682B			
with thermal paste 17mm housing with solder pins					10-F006PPA006SB-M682B/-3/			
without thermal paste 12mm housing with Press-fit pins					10-PC06PPA006SB-M682B06Y			
NN-NNNNNNNNNNNN TTTTTTVVVVVV UL VIN LLLL SSSS			Text Datamatrix	VIN	Date code	Name&Ver	UL	
				VIN	WWYY	NNNNNNVV	UL	
				Type&Ver	Lot number	Serial	Date code	
			TTTTTTTV		LLLLL	SSSS	WWYY	

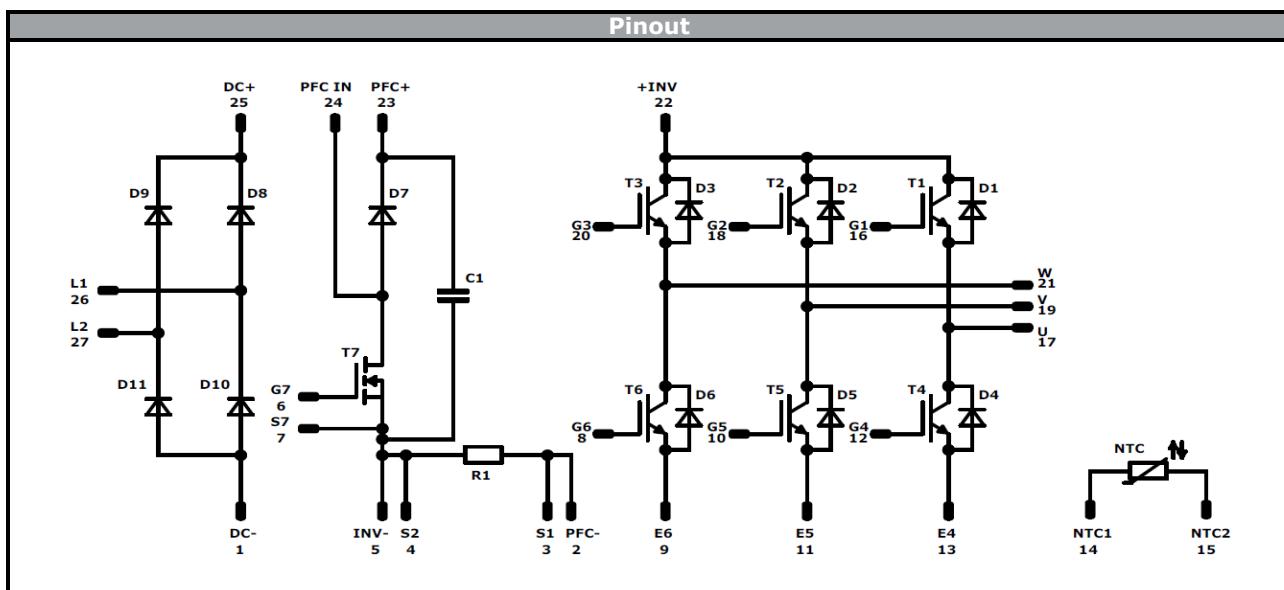
Outline																																																																																																																							
Pin table				Outline																																																																																																																			
<table border="1"> <thead> <tr> <th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr> </thead> <tbody> <tr><td>1</td><td>33,5</td><td>0</td><td>DC-</td></tr> <tr><td>2</td><td>30,7</td><td>0</td><td>PFC-</td></tr> <tr><td>3</td><td>28</td><td>0</td><td>S1</td></tr> <tr><td>4</td><td>25,3</td><td>0</td><td>S2</td></tr> <tr><td>5</td><td>22,6</td><td>0</td><td>INV-</td></tr> <tr><td>6</td><td>19,9</td><td>0</td><td>G7</td></tr> <tr><td>7</td><td>17,2</td><td>0</td><td>S7</td></tr> <tr><td>8</td><td>13,5</td><td>0</td><td>G6</td></tr> <tr><td>9</td><td>10,8</td><td>0</td><td>E6</td></tr> <tr><td>10</td><td>8,1</td><td>0</td><td>G5</td></tr> <tr><td>11</td><td>5,4</td><td>0</td><td>E5</td></tr> <tr><td>12</td><td>2,7</td><td>0</td><td>G4</td></tr> <tr><td>13</td><td>0</td><td>0</td><td>E4</td></tr> <tr><td>14</td><td>0</td><td>8,6</td><td>NTC1</td></tr> <tr><td>15</td><td>0</td><td>11,45</td><td>NTC2</td></tr> <tr><td>16</td><td>0</td><td>19,8</td><td>G1</td></tr> <tr><td>17</td><td>0</td><td>22,5</td><td>U</td></tr> <tr><td>18</td><td>6</td><td>19,8</td><td>G2</td></tr> <tr><td>19</td><td>6</td><td>22,5</td><td>V</td></tr> <tr><td>20</td><td>12</td><td>19,8</td><td>G3</td></tr> <tr><td>21</td><td>12</td><td>22,5</td><td>W</td></tr> <tr><td>22</td><td>17,7</td><td>22,5</td><td>INV+</td></tr> <tr><td>23</td><td>20,5</td><td>22,5</td><td>PFC+</td></tr> <tr><td>24</td><td>26,5</td><td>22,5</td><td>PFC IN</td></tr> <tr><td>25</td><td>33,5</td><td>22,5</td><td>DC+</td></tr> <tr><td>26</td><td>33,5</td><td>15</td><td>L1</td></tr> <tr><td>27</td><td>33,5</td><td>7,5</td><td>L2</td></tr> </tbody> </table>				Pin	X	Y	Function	1	33,5	0	DC-	2	30,7	0	PFC-	3	28	0	S1	4	25,3	0	S2	5	22,6	0	INV-	6	19,9	0	G7	7	17,2	0	S7	8	13,5	0	G6	9	10,8	0	E6	10	8,1	0	G5	11	5,4	0	E5	12	2,7	0	G4	13	0	0	E4	14	0	8,6	NTC1	15	0	11,45	NTC2	16	0	19,8	G1	17	0	22,5	U	18	6	19,8	G2	19	6	22,5	V	20	12	19,8	G3	21	12	22,5	W	22	17,7	22,5	INV+	23	20,5	22,5	PFC+	24	26,5	22,5	PFC IN	25	33,5	22,5	DC+	26	33,5	15	L1	27	33,5	7,5	L2	 <p>17mm housing</p>			
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Identification					
ID	Component	Voltage	Current	Function	Comment
T1,T2,T3,T4,T5,T6	IGBT	600 V	6 A	Inverter Switch	
D1,D2,D3,D4,D5,D6	FWD	600 V	6 A	Inverter Diode	
T7	MOSFET	600 V	190 mΩ	PFC Switch	
D7	FWD	600 V	6 A	PFC Diode	
D8,D9,D10,D11	Rectifier	1600 V	25 A	Rectifier Diode	
R1	Resistor			PFC Shunt	
C1	Capacitor	500 V		Capacitor (DC)	
NTC	Thermistor			Thermistor	



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Packaging instruction		>SPQ	Standard	<SPQ	Sample
Standard packaging quantity (SPQ)	135				

Handling instruction
Handling instructions for <i>flow</i> 0 packages see vincotech.com website.

Package data
Package data for <i>flow</i> 0 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-xx06PPA006SB-M682Bx-D2-14	30 May. 2016	New brand, PCM Rth values	all

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.